

BREMEN-M 15"/17"

CPU : Intel Arrandale
Chip Set : Intel Ixex Peak(HM55)
GFX : N11P/ M-GE1(40nm)
Remarks : Calpella Platform

Model Name	: BREMEN-M
PBA Name	: MAIN
PCB Code	: BA41-01174A
Dev. Step	: PR
Revision	: 1.0
T.R. Date	: 2009.11.12

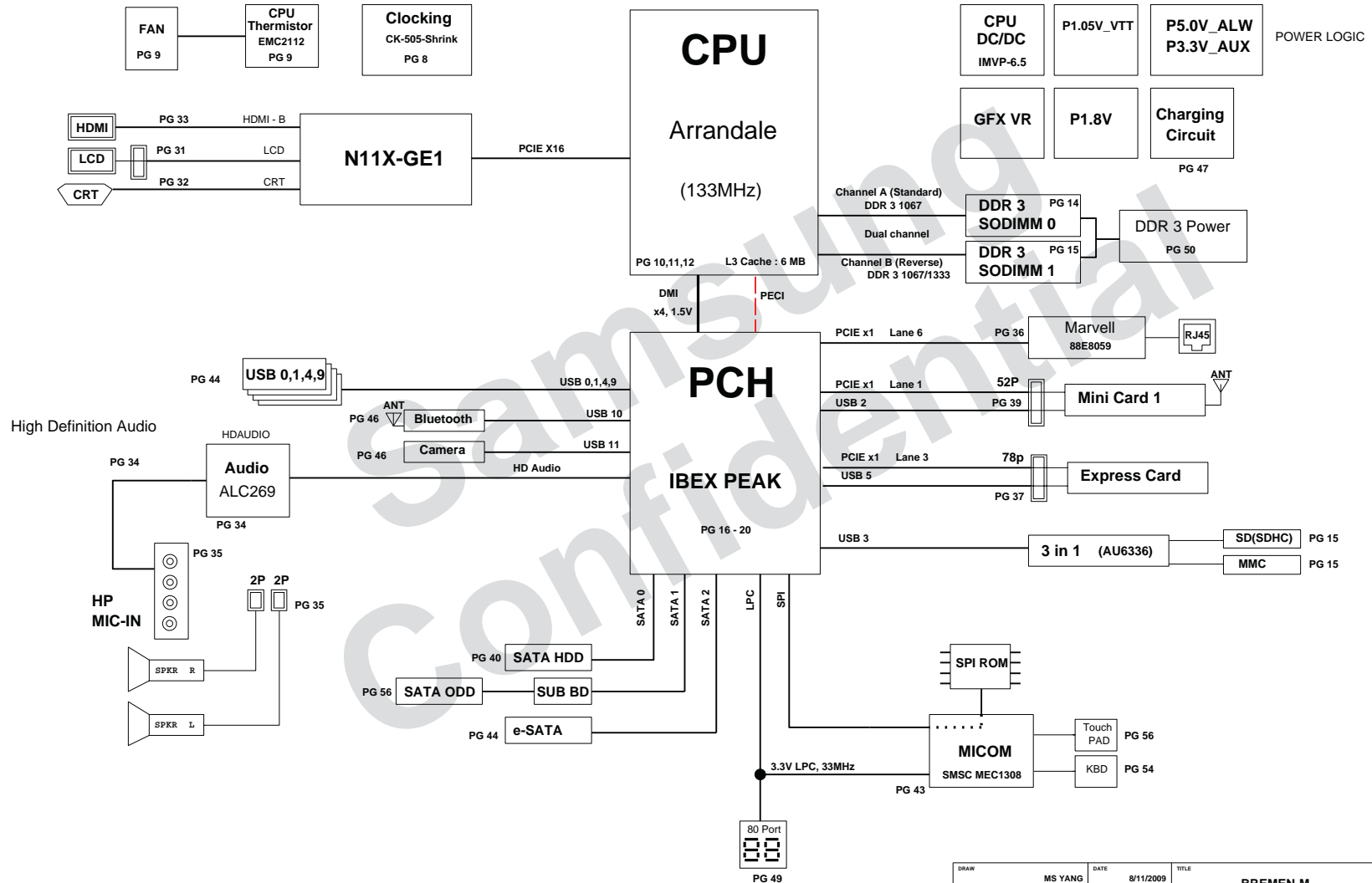
Design	CHECK	APPROVAL

Owner : SEC Mobile R & D Signature : X

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- Cover
- Diagram (Block/Power) & Annotations
- Clock Generator -CK505 Shrink Version
- Thermal Sensor & FAN
- Arrandale CPU
- DDR3 SODIMM A
- DDR3 SODIMM B
- IBEX PEAK
- GFx_External_N11X
- Graphics_Memory_gDDR3 1g bit
- Graphic Strap
- Graphic Interface
- High Definition Audio (ALC269Q-GR)
- LAN_Marvell_88E8059
- Express_Card
- MultiCard_AU6336 (3 in 1)
- PCIE_Minicard_Slot (Half type only)
- SATA I/F CONN
- MICOM_MEC1308-NU
- Micom Glue Logic
- LED_Switch
- USB Port
- Touchpad LED
- USB Interface
- Charger
- PWR_3V_5V
- PWR_Calpella
- PWR_Memory
- PWR_CPU_VRM
- PWR_GFX_Ext
- PWR_MV_Switched
- PWR_MV_DisCharger
- 2 USB Port & Power S/W SUB B'D
- SATA ODD SUB B'D Battery IF B'D
- EMC Capacitor & ICT Port

DRAW	MS YANG	DATE	8/11/2009	TITLE	BREMEN-M	SAMSUNG
CHECK	SE LEE	DEV. STEP	PV		MAIN	ELECTRONICS
APPROVAL	MK KIM	REV	REV 0.9		COVER	PART NO.
MODULE CODE		LAST EDIT				BA41-01174A
				October 20, 2009 21:30:55 PM	PAGE	1 OF 56

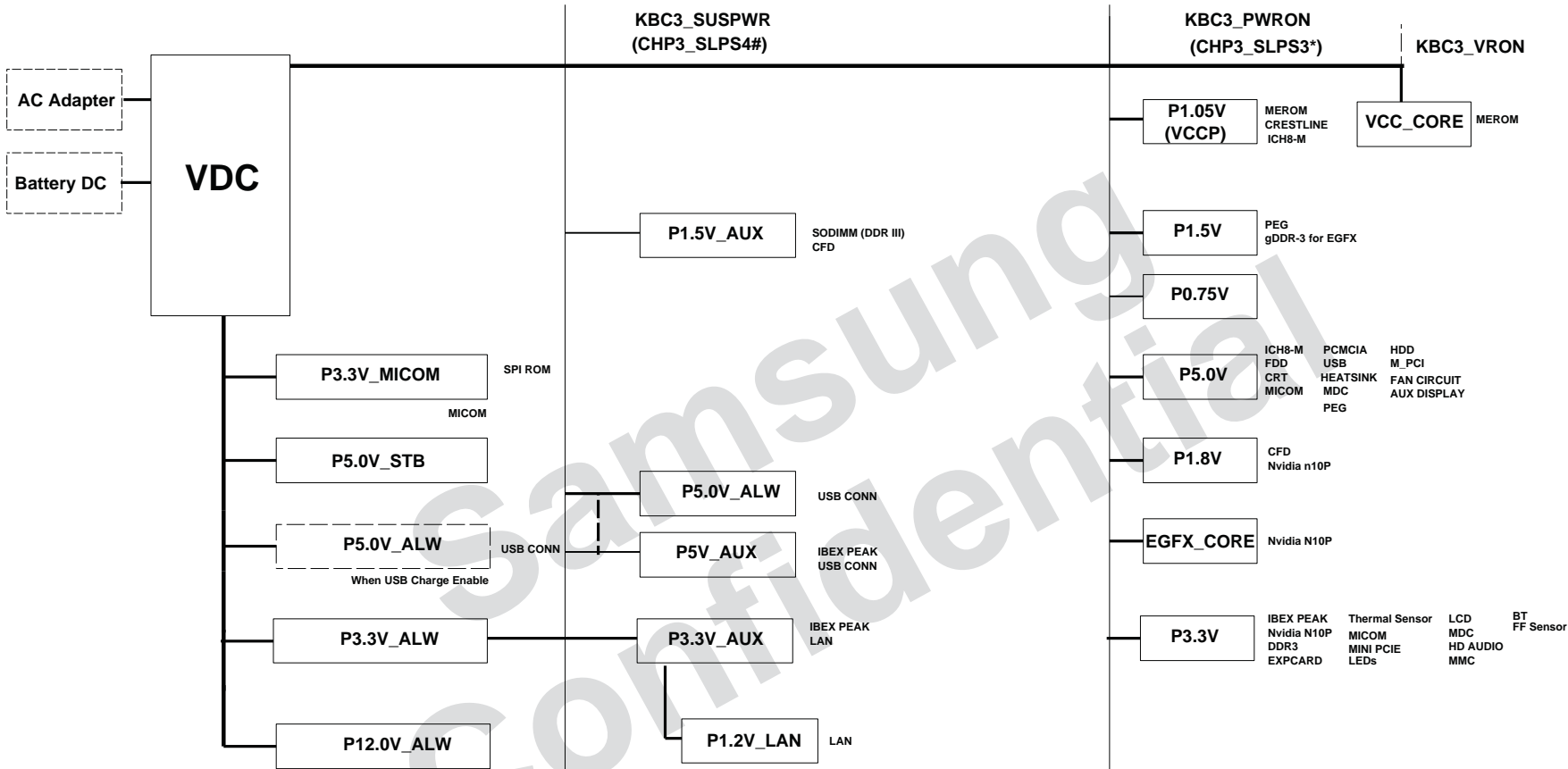
BLOCK DIAGRAM



DRAW	MS YANG	DATE	8/11/2009	TITLE	BREMEN-M MAIN	SAMSUNG ELECTRONICS
CHECK	SE LEE	DEV. STEP	PV			
APPROVAL	MK KIM	REV	REV 0.9			
MODULE CODE	undefined	LAST EDIT				
				October 20, 2009 21:30:55 PM	PAGE 2 OF 56	

POWER DIAGRAM

Rev 0.1



Power On/Off Table by S-state

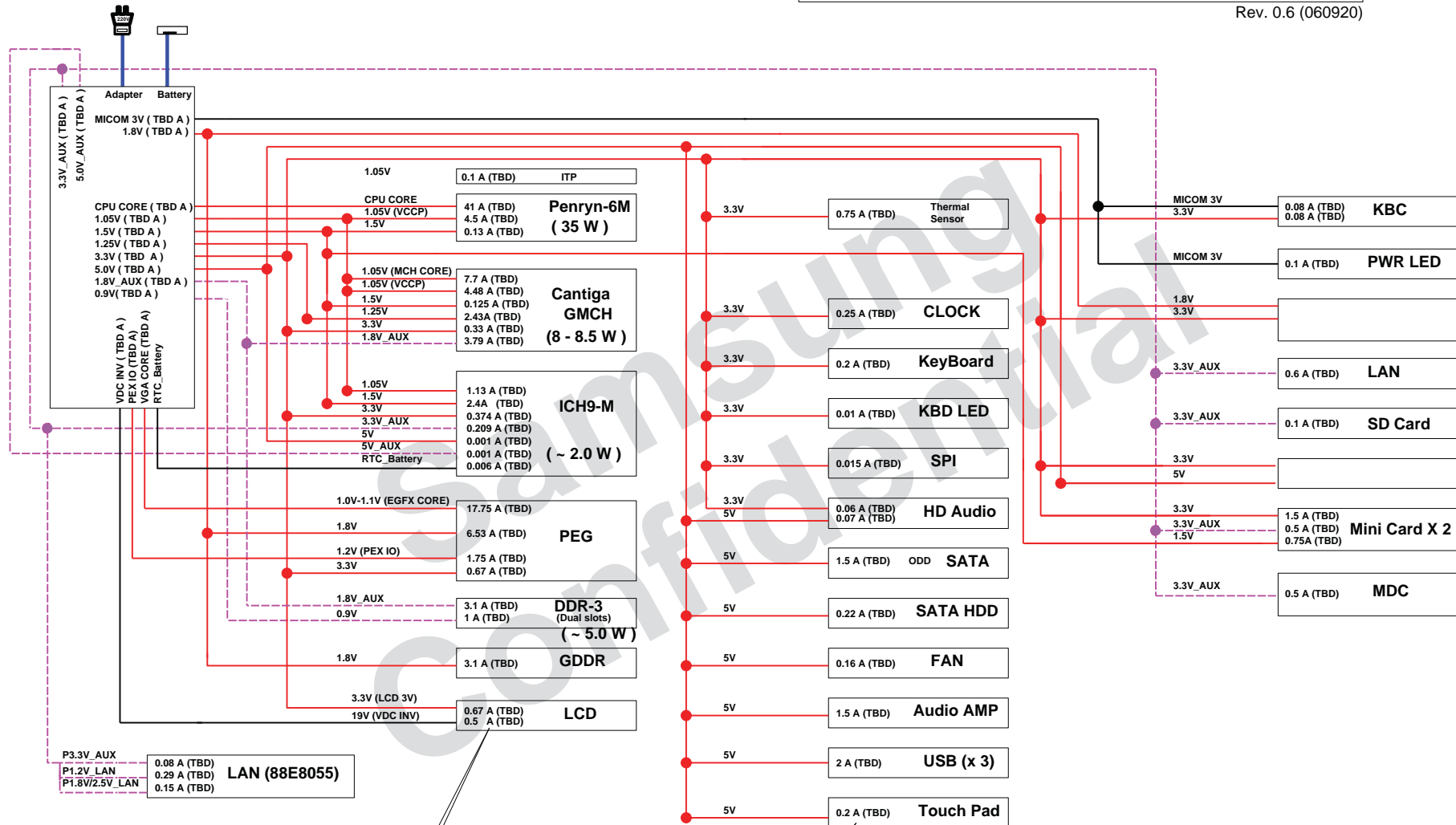
Rail State	S0	S3	S4	S5
+V*A(LWS) +V*LAN	ON	ON	ON	ON
+1.8V_AUX +0.9V	ON	ON	—	—
+V*AUX	ON	ON	—	—
+V	ON	—	—	—
+V* (CORE)	ON	—	—	—



DRAW	MS YANG	DATE	8/11/2009	TITLE	BREMEN-M MAIN	SAMSUNG ELECTRONICS
CHECK	SE LEE	DEV. STEP	PV			
APPROVAL	MK KIM	REV	REV 0.9		POWER DIAGRAM	PART NO. BA41-01174A
MODULE CODE	undefined	LAST EDIT		October 20, 2009 21:30:55 PM	PAGE	3 OF 56

POWER RAILS ANALYSIS

Rev. 0.6 (060920)



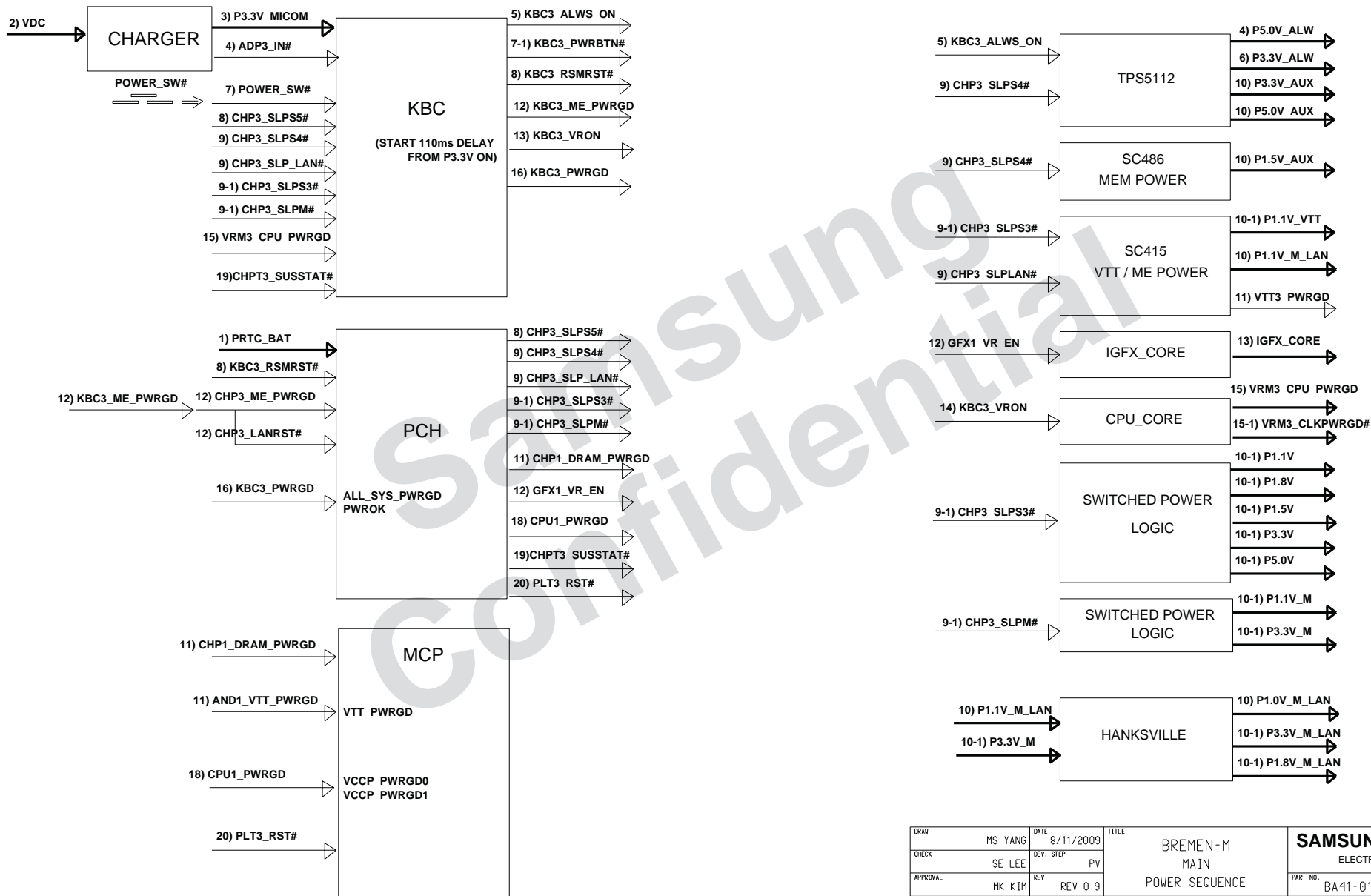
Value by Datasheet/Application notes (Value by measurement)

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				October 20, 2009 21:30:55 PM	PAGE	4 OF 56

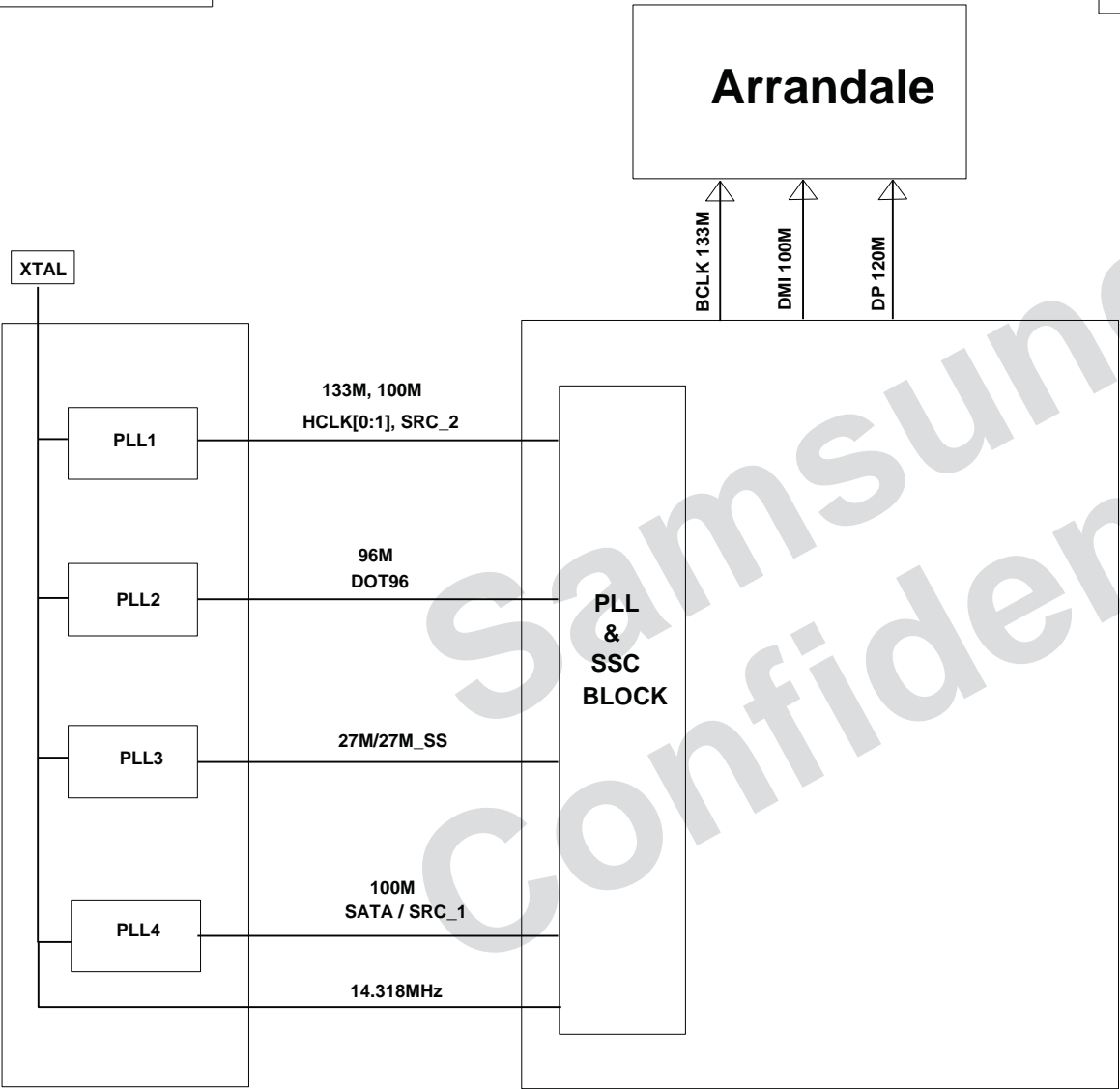
PRELIMINARY

POWER SEQUENCE

Rev. 0.5

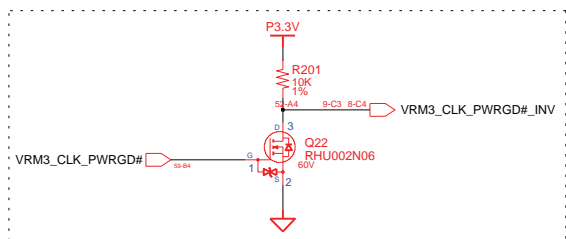
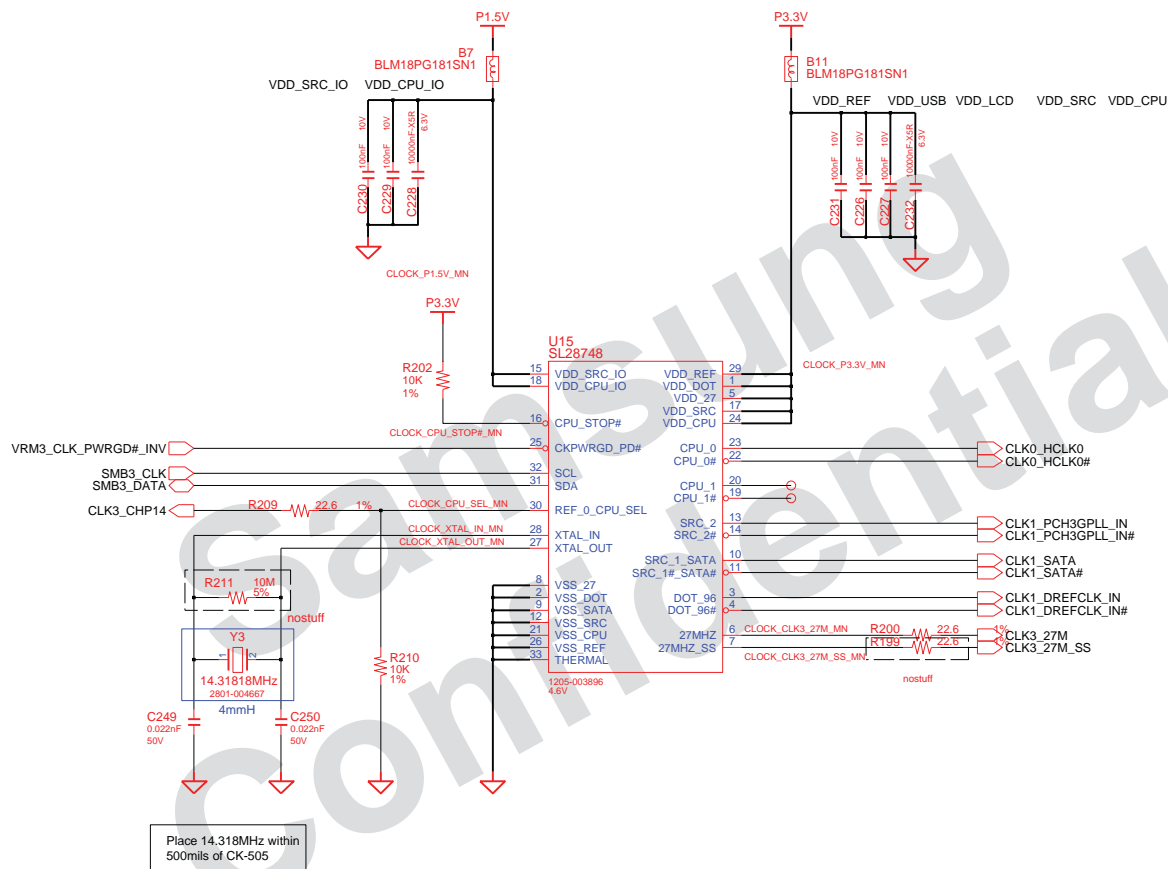


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MODULE CODE	undefined	LAST EDIT	October 20, 2009 21:30:55 PM	PAGE	5	OF 56



DRAW	MS YANG	DATE	8/11/2009	BREMEN-M MAIN		SAMSUNG ELECTRONICS	
CHECK	SE LEE	DEV. STEP	PV				
APPROVAL	MK KIM	REV	REV 0.9	CLOCK DIAGRAM		PART NO. BA41-01174A	
MODULE CODE	undefined	LAST EDIT		October 20, 2009 21:30:55 PM		PAGE	6 OF 56

Pin 30	CPU_0	CPU_1
CPU_SEL = 0	133MHz	133MHz

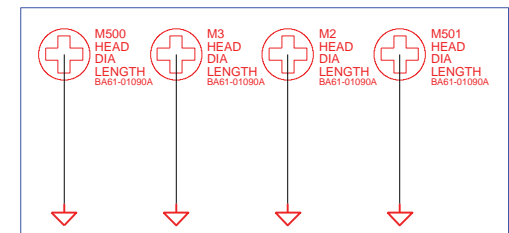
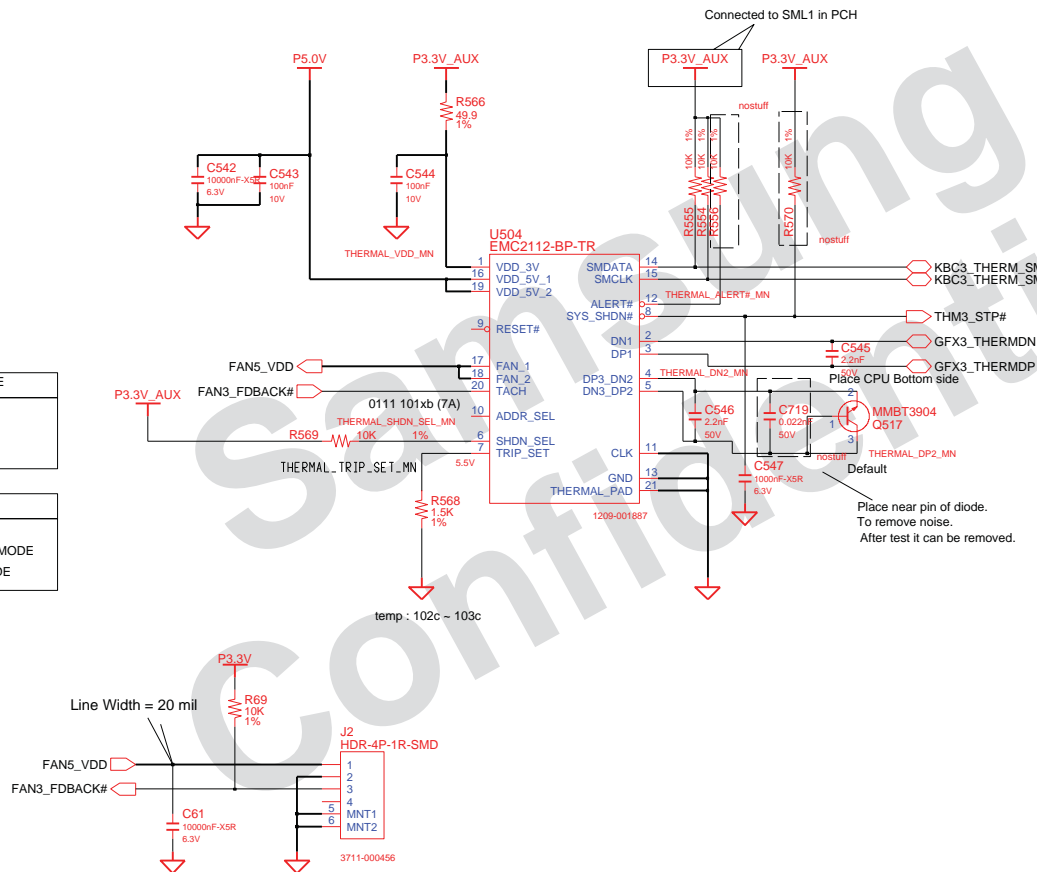


DESIGN	MS YANG	DATE	8/11/2009	BREMEN-M CLOCK CK505-SHRINK	SAMSUNG ELECTRONICS	PART NO. BA41-01174A
CHECK	SE LEE	DEV. STEP	PV			
APPROVAL	MK KIM	REV	REV 0.9			
MODULE CODE	LAST EDIT					

THERMAL SENSOR & FAN CONTROL

ADDRESSSEL MODE	
0	0101 111xb
✓ HIGH Z	0111 101xb (7A)
1	0101 110xb

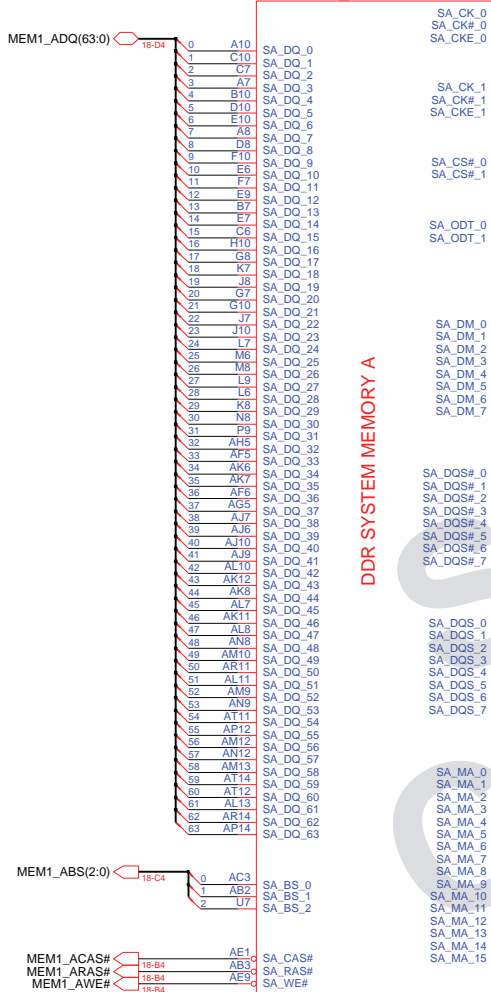
SHDNSEL MODE	
0	INTEL TR MODE
HIGH Z	AMD CPU/DIODE MODE
✓ 1	EXT.DIODE 2 MODE



To support heatsink

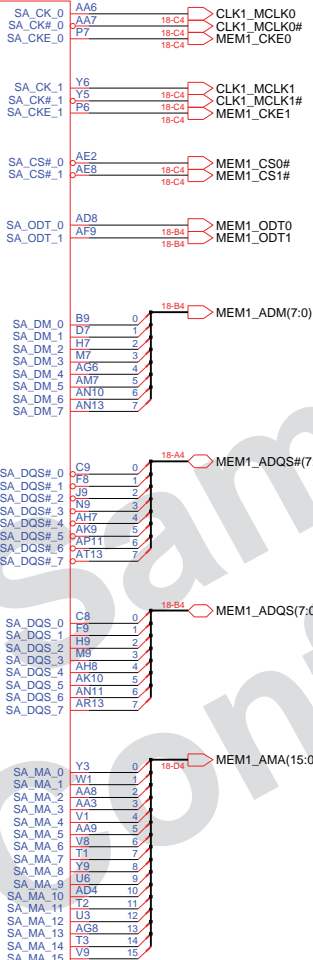
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CHECK	SE LEE	DEV. STEP	PV			
APPROVAL	MK KIM	REV	REV 0.9		THERMAL SENSOR EMC2112	PART NO. BA41-01174A
MODULE CODE		LAST EDIT				
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CPU1-2
ARD/CFD_PGA 2/5

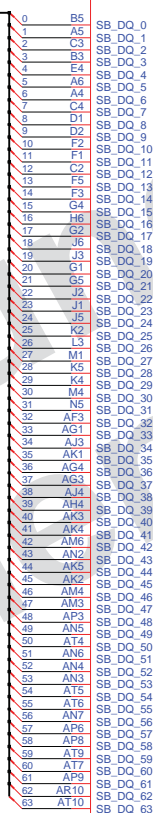


DDR SYSTEM MEMORY A

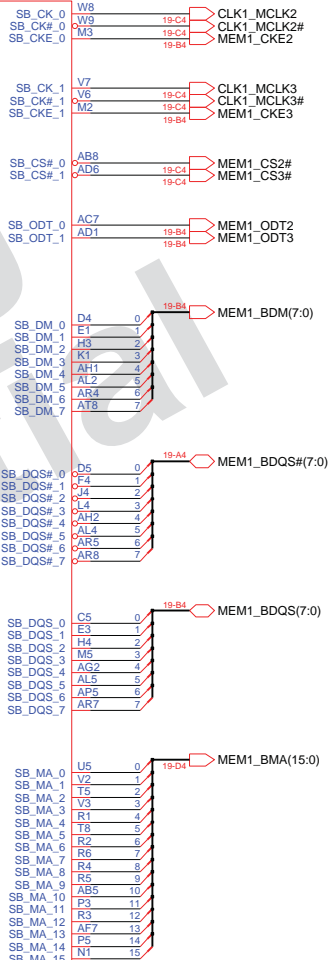
0902-002514



MEM1_BDQ(63:0) 19-D4



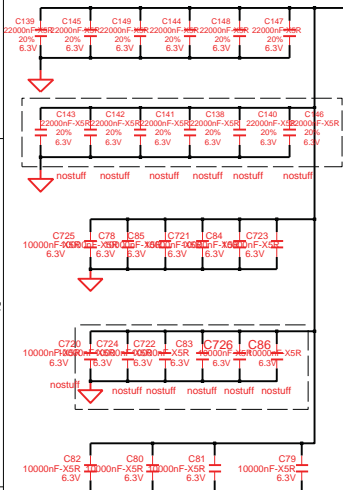
DDR SYSTEM MEMORY B



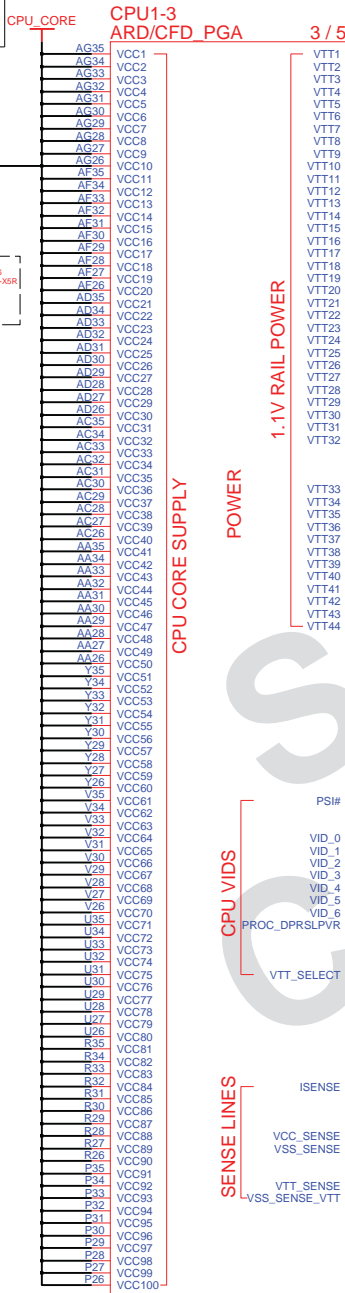
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APPROVAL	MK KIM	REV	REV 0.9			
MODULE CODE	undefined	LAST EDIT		October 20, 2009 21:30:55 PM	PAGE 10 OF 56	

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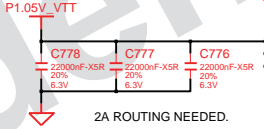
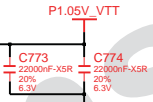
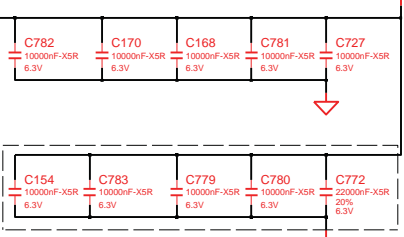
4x 470 uF : CPU VR side



Stuff/NoStuff Check ?
(depends on placement)

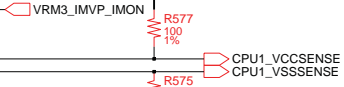


ALL VTT DECAP IS SHARED

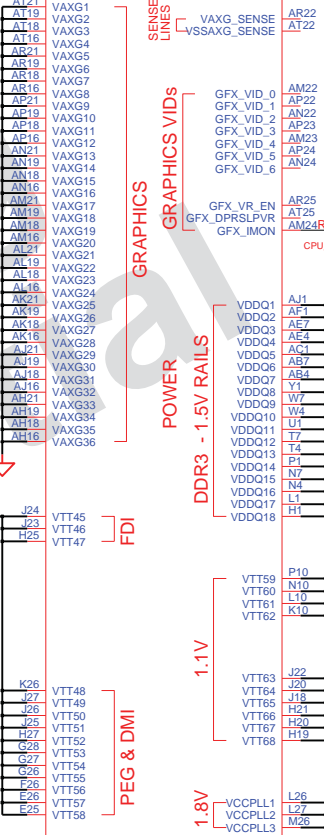


VTT_SEL	VOLTAGE	CPU
1	P1.05V	ARRANDALE
0	P1.1V	CLARKS FIELD

VTT_SEL signal (for CFD/ARD shared) CPU CORE



CPU1-4 ARD/CFD PGA 4 / 5



SENSE LINES VAXG_SENSE VSSAXG_SENSE

GRAPHICS VIDS

POWER

DDR3 - 1.5V RAILS

1.1V

1.8V

DESIGN	MS YANG	DATE	8/11/2009	TITLE	BREMEN-M CPU	SAMSUNG ELECTRONICS
CHECK	SE LEE	DEV. STEP	PV	ARRANDALE (3/4)	PART NO.	BA41-01174A
APPROVAL	MK KIM	REV	REV 0.9	October 20, 2009 21:30:55 PM	PAGE	11 OF 56
MODULE CODE		LAST EDIT				

CPU1-5
ARD/CFD_PG45/5

AT20	VSS1	VSS81	AE34
AT31	VSS2	VSS82	AE33
AR31	VSS3	VSS83	AE32
AR28	VSS4	VSS84	AE31
AR26	VSS5	VSS85	AE30
AR24	VSS6	VSS86	AE29
AR23	VSS7	VSS87	AE28
AR20	VSS8	VSS88	AE27
AR17	VSS9	VSS89	AE26
AR15	VSS10	VSS90	AE6
AR12	VSS11	VSS91	AD10
AR9	VSS12	VSS92	AC2
AR6	VSS13	VSS93	AC2
AR3	VSS14	VSS94	AC2
AP20	VSS15	VSS95	AB35
AP17	VSS16	VSS96	AB34
AP13	VSS17	VSS97	AB33
AP10	VSS18	VSS98	AB32
AP7	VSS19	VSS99	AB31
AP4	VSS20	VSS100	AB30
AN20	VSS21	VSS101	AB29
AN34	VSS22	VSS102	AB28
AN31	VSS23	VSS103	AB27
AN23	VSS24	VSS104	AB26
AN20	VSS25	VSS105	AB25
AN17	VSS26	VSS106	AA10
AM29	VSS27	VSS107	Y8
AM27	VSS28	VSS108	Y4
AM25	VSS29	VSS109	W35
AM20	VSS30	VSS110	W34
AM17	VSS31	VSS111	W33
AM14	VSS32	VSS112	W32
AM11	VSS33	VSS113	W31
AM8	VSS34	VSS114	W30
AM2	VSS35	VSS115	W29
AL34	VSS36	VSS116	W28
AL31	VSS37	VSS117	W27
AL23	VSS38	VSS118	W26
AL20	VSS39	VSS119	W25
AL17	VSS40	VSS120	W24
AL12	VSS41	VSS121	W23
AL9	VSS42	VSS122	W22
AL6	VSS43	VSS123	W21
AL3	VSS44	VSS124	W20
AK29	VSS45	VSS125	W19
AK27	VSS46	VSS126	W18
AK25	VSS47	VSS127	W17
AK20	VSS48	VSS128	W16
AK17	VSS49	VSS129	W15
AK13	VSS50	VSS130	W14
AK10	VSS51	VSS131	W13
AK7	VSS52	VSS132	W12
AK4	VSS53	VSS133	W11
AK1	VSS54	VSS134	W10
AK1	VSS55	VSS135	W9
AK1	VSS56	VSS136	W8
AK1	VSS57	VSS137	W7
AK1	VSS58	VSS138	W6
AK1	VSS59	VSS139	W5
AK1	VSS60	VSS140	W4
AK1	VSS61	VSS141	W3
AK1	VSS62	VSS142	W2
AK1	VSS63	VSS143	W1
AK1	VSS64	VSS144	N31
AK1	VSS65	VSS145	N30
AK1	VSS66	VSS146	N29
AK1	VSS67	VSS147	N28
AK1	VSS68	VSS148	N27
AK1	VSS69	VSS149	N26
AK1	VSS70	VSS150	N25
AK1	VSS71	VSS151	N24
AK1	VSS72	VSS152	N23
AK1	VSS73	VSS153	N22
AK1	VSS74	VSS154	N21
AK1	VSS75	VSS155	N20
AK1	VSS76	VSS156	N19
AK1	VSS77	VSS157	N18
AK1	VSS78	VSS158	N17
AK1	VSS79	VSS159	N16
AK1	VSS80	VSS160	N15

K27	VSS161
K8	VSS162
K3	VSS163
K32	VSS164
J30	VSS165
J21	VSS166
J19	VSS167
H35	VSS168
H32	VSS169
H28	VSS170
H26	VSS171
H24	VSS172
H22	VSS173
H18	VSS174
H15	VSS175
H13	VSS176
H11	VSS177
H8	VSS178
H5	VSS179
H2	VSS180
G34	VSS181
G31	VSS182
G20	VSS183
G16	VSS184
G6	VSS185
G3	VSS186
F30	VSS187
F27	VSS188
F25	VSS189
F22	VSS190
F19	VSS191
F16	VSS192
F13	VSS193
F11	VSS194
F8	VSS195
F5	VSS196
E24	VSS197
E21	VSS198
E18	VSS199
E13	VSS200
E11	VSS201
E8	VSS202
E5	VSS203
E2	VSS204
D33	VSS205
D30	VSS206
D26	VSS207
D23	VSS208
D20	VSS209
D17	VSS210
D14	VSS211
D12	VSS212
D9	VSS213
D6	VSS214
D3	VSS215
C34	VSS216
C28	VSS217
C26	VSS218
C24	VSS219
C22	VSS220
C20	VSS221
C19	VSS222
C16	VSS223
C15	VSS224
C14	VSS225
C13	VSS226
C12	VSS227
C11	VSS228
C10	VSS229
C9	VSS230
C8	VSS231
C7	VSS232
C6	VSS233

VSS

NCTF

AT35
AT1
AR34
B34
B2
B1
A35

1% 3.01K R616
CPU_CFG_7_MN

AP25	RSVD1	RSVD32	AJ13
AL25	RSVD2	RSVD33	AJ12
AL24	RSVD3	RSVD34	AH25
AL22	RSVD4	RSVD35	AK26
AJ33	RSVD5	RSVD36	AL26
AG9	RSVD6	RSVD37_37	AR2
M27	RSVD7	RSVD38	AJ26
L28	RSVD8	RSVD39	AJ27
H7	SA_DIMM_VREFDQ		
H17	SB_DIMM_VREFDQ		
G25	RSVD11		
G17	RSVD12	RSVD_NCTF_40	AP1
E31	RSVD13	RSVD_NCTF_41	AT2
E30	RSVD14	RSVD_NCTF_42	AT3
		RSVD_NCTF_43	AR1
AM30	CFG_0	RSVD45	AL28
AM28	CFG_1	RSVD46	AL29
AP31	CFG_2	RSVD47	AP30
AL32	CFG_3	RSVD48	AP32
AL30	CFG_4	RSVD49	AL27
AM31	CFG_5	RSVD50	AT31
AN29	CFG_6	RSVD51	AP33
AM32	CFG_7	RSVD52	AR33
AK32	CFG_8	RSVD_NCTF_54	AT33
AK31	CFG_9	RSVD_NCTF_55	AT34
AK28	CFG_10	RSVD_NCTF_56	AP35
AJ28	CFG_11	RSVD_NCTF_57	AR35
AN30	CFG_12	RSVD58	AR32
AN32	CFG_13		
AJ32	CFG_14		
AJ29	CFG_15	RSVD_TP_69	E15
AJ30	CFG_16	RSVD_TP_69	F15
AK30	CFG_17	KEY	A2
H16	RSVD_TP_86	RSVD62	D15
		RSVD63	C15
		RSVD64	AJ15
		RSVD65	AH15
B19	RSVD15		
A19	RSVD16		
A20	RSVD17		
B20	RSVD18		
U9	RSVD19	RSVD_TP_66	AA5
T9	RSVD20	RSVD_TP_67	AA4
AC9	RSVD21	RSVD_TP_68	R8
AB9	RSVD22	RSVD_TP_69	AD3
		RSVD_TP_70	AD2
		RSVD_TP_71	AA2
		RSVD_TP_72	AA1
		RSVD_TP_73	R9
		RSVD_TP_74	AE3
		RSVD_TP_75	
C1	RSVD_NCTF_23		
A3	RSVD_NCTF_24		
J29	RSVD26	RSVD_TP_76	V4
J28	RSVD27	RSVD_TP_77	V5
		RSVD_TP_78	N2
		RSVD_TP_79	AD5
		RSVD_TP_80	AD7
		RSVD_TP_81	W2
A34	RSVD_NCTF_28	RSVD_TP_82	N3
A33	RSVD_NCTF_29	RSVD_TP_83	AE5
C35	RSVD_NCTF_30	RSVD_TP_84	AD9
B35	RSVD_NCTF_31	RSVD_TP_85	
	(VSS) RSVD86		AP34

RESERVED

CRB is NC
EDS/DG is GND recommend

CFG Straps for Processor

PCI Express Configuration Select	
CFG0	1 : Single PEG 0 : Bifunction enabled

PCI Express Static Lane Reversal	
CFG3	1 : Normal operation 0 : Lane Reversed

Display Port Presence	
CFG4	1 : Disabled - No DP device is connected to eDP 0 : Enabled - (DP device is connected to eDP

PCIe 2.0 SUPPORT	
CFG7	1 : Normal operation 0 : PCIe2.0 Jitter support

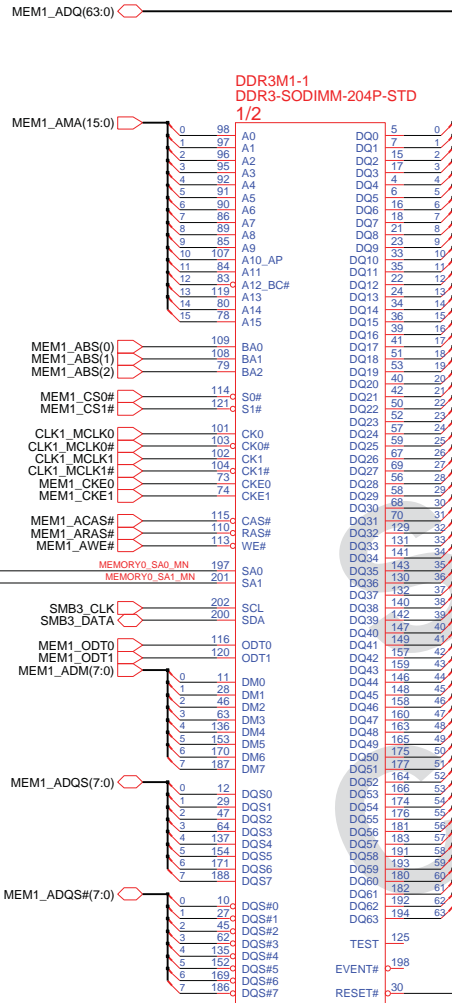
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CHECK	SE LEE	DEV. STEP	PV		ARRANDALE (4/4)	PART NO. BA41-01174A
APPROVAL	MK KIM	REV	REV 0.9			
MODULE CODE	undefined	LAST EDIT				
				October 20, 2009 21:30:55 PM	PAGE	12 OF 56

DDR SO-DIMM #0

Height : 4 mm (STANDARD)

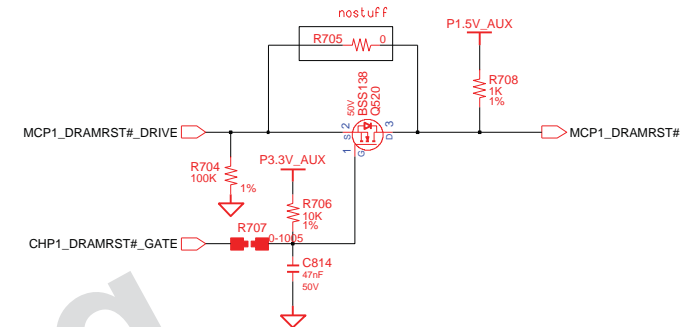
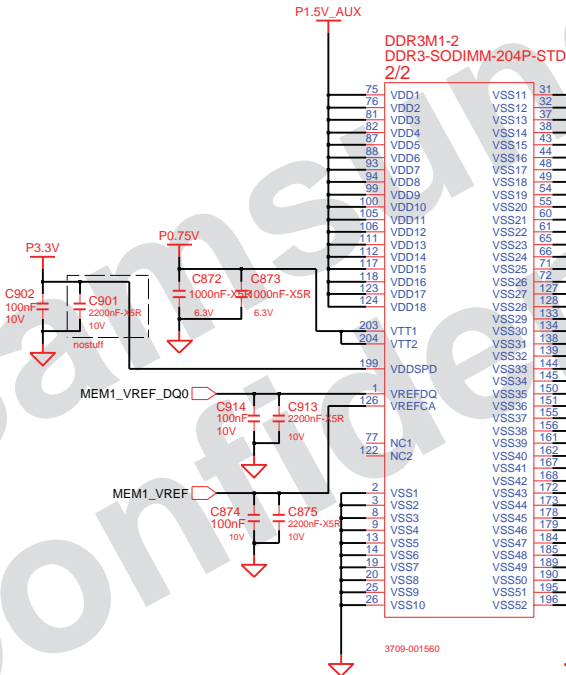
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P/N : 3709-001560 (Foxconn)

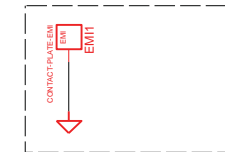


DDR3M1-1
DDR3-SODIMM-204P-STD
1/2

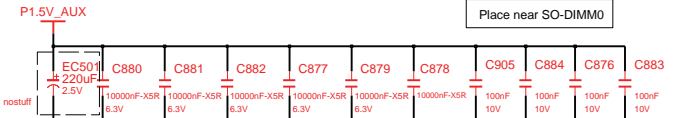
DDR3M1-2
DDR3-SODIMM-204P-STD
2/2



Place between two memory Connector



Place near SO-DIMM



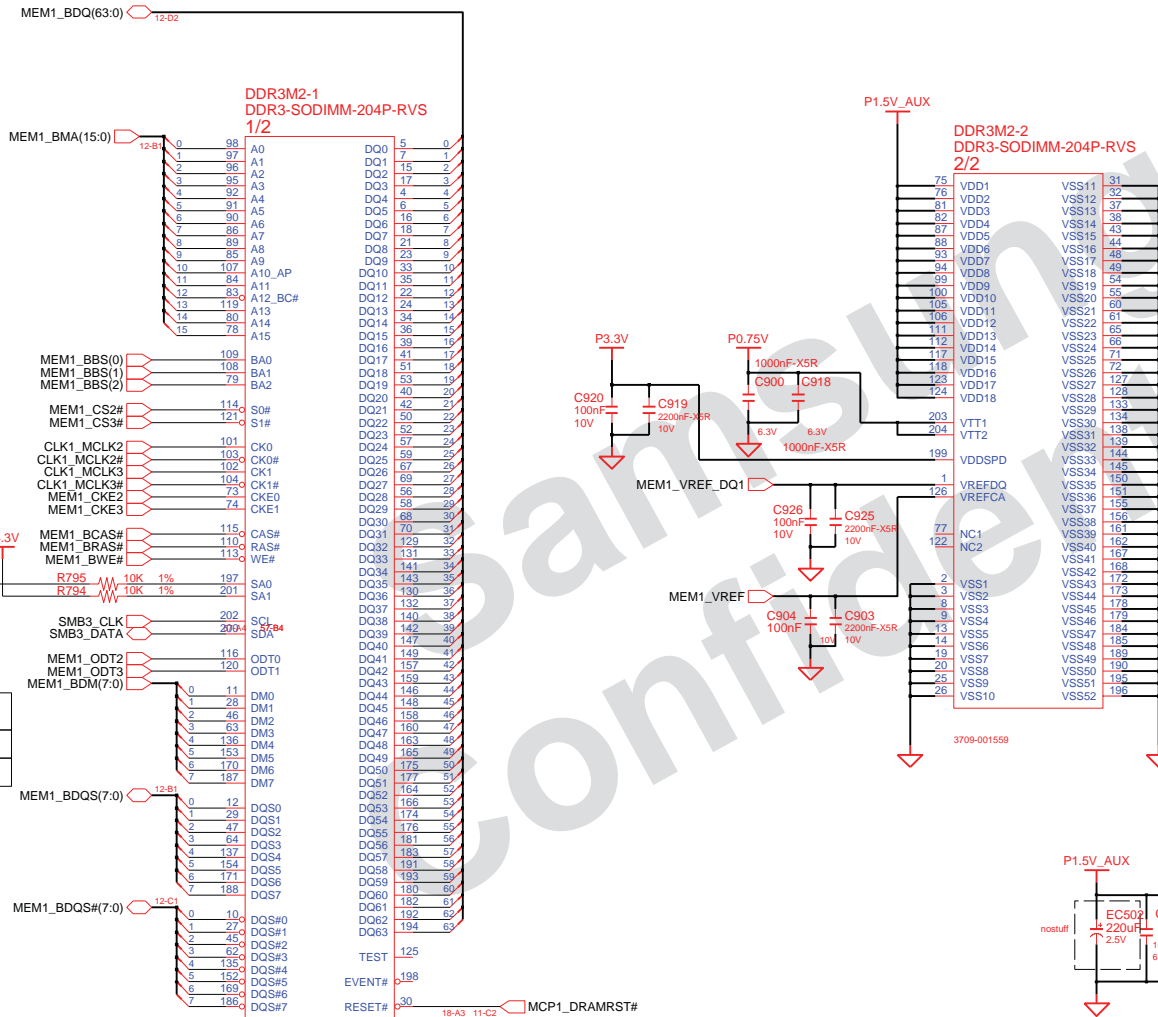
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CHECK	SE LEE	DEV. STEP	PV			
APPROVAL	MK KIM	REV	REV 0.9			
MODULE CODE		LAST EDIT				
October 20, 2009 21:30:55 PM						PAGE 13 OF 56

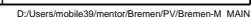
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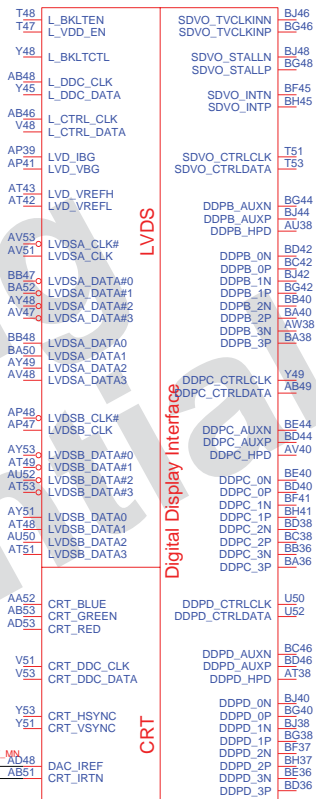
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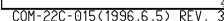
P/N : 3709-001559 (Foxconn)







COM-22C-015(1996.6.5) REV. 3

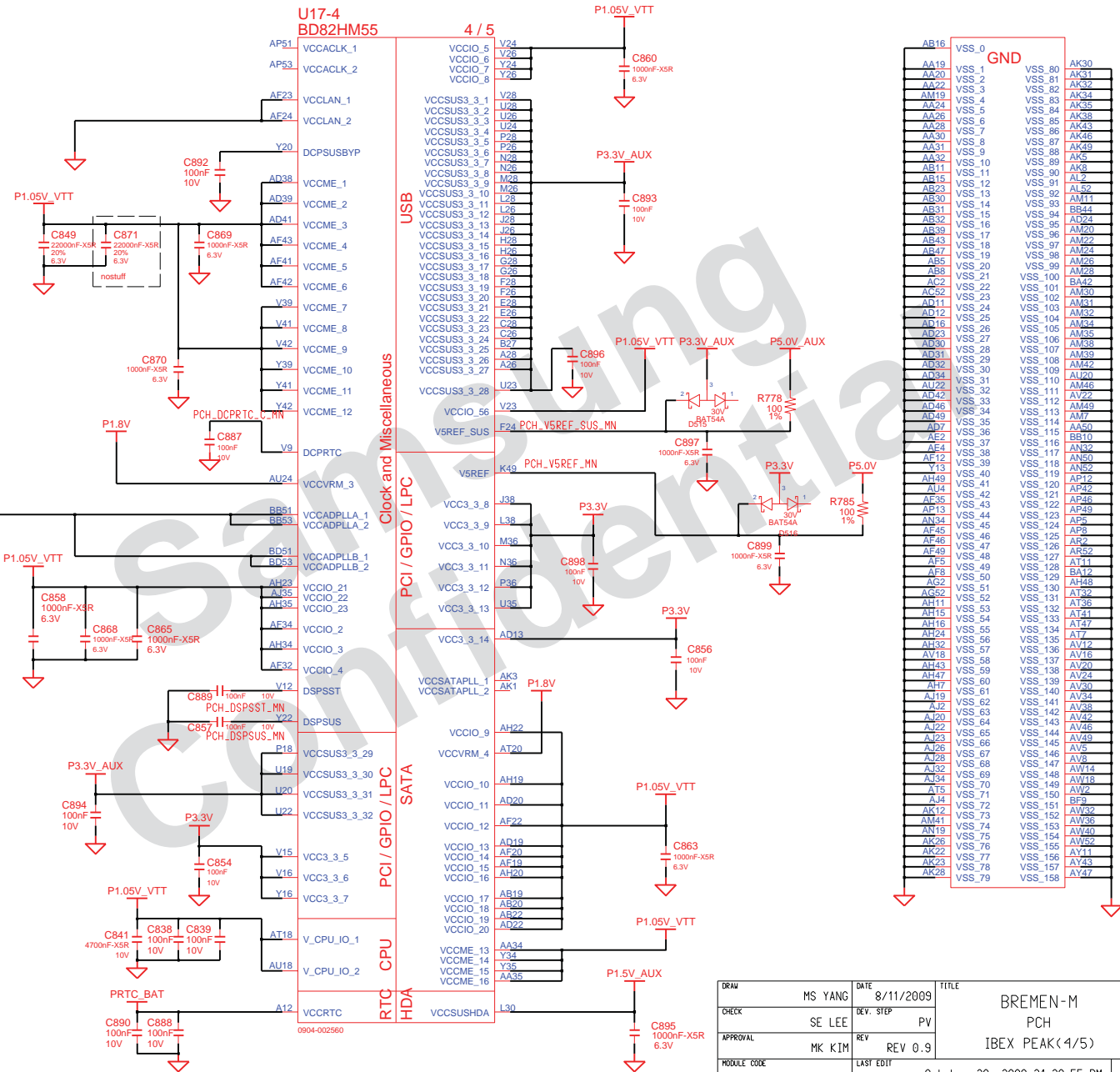


D

C

B

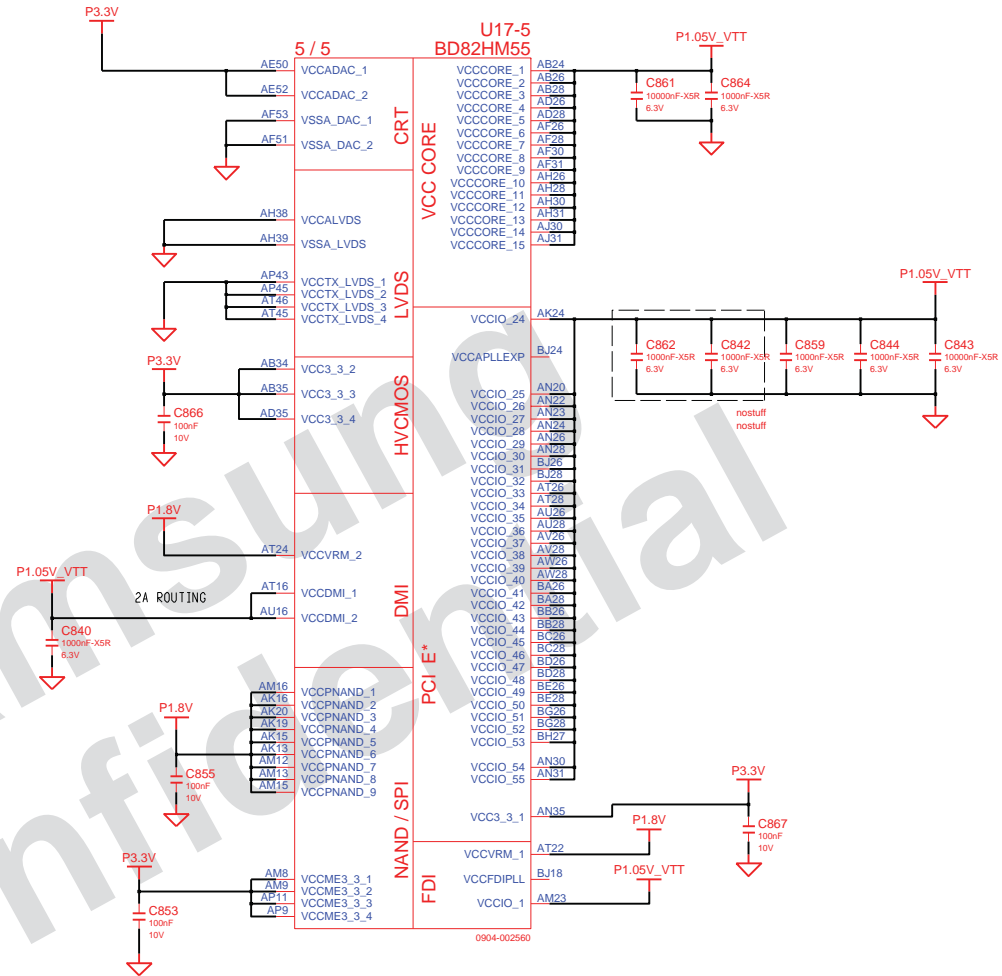
A



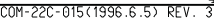
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CHECK	SE LEE	DEV. STEP	PV			
APPROVAL	MK KIM	REV	REV 0.9			
MODULE CODE		LAST EDIT				
				October 20, 2009 21:30:55 PM	PAGE 18	OF 606

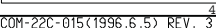
This power share with thermal sensor

H49	VSS_259	VSS_159	AY7
H5	VSS_260	VSS_160	B11
J24	VSS_261	VSS_161	B15
K11	VSS_262	VSS_162	B19
K43	VSS_263	VSS_163	B23
K7	VSS_264	VSS_164	B35
L14	VSS_265	VSS_165	B39
L18	VSS_266	VSS_166	B43
L2	VSS_267	VSS_167	B47
L22	VSS_268	VSS_168	B7
L32	VSS_269	VSS_169	BG12
L36	VSS_270	VSS_170	BH12
L40	VSS_271	VSS_171	BH16
L52	VSS_272	VSS_172	BH20
M12	VSS_273	VSS_173	BB24
M16	VSS_274	VSS_174	BB30
M20	VSS_275	VSS_175	BB34
N38	VSS_276	VSS_176	BB38
N34	VSS_277	VSS_177	BB42
M38	VSS_278	VSS_178	BB49
M42	VSS_279	VSS_179	BB55
M46	VSS_280	VSS_180	BC10
M49	VSS_281	VSS_181	BC14
M5	VSS_282	VSS_182	BC18
M8	VSS_283	VSS_183	BC2
N24	VSS_284	VSS_184	BC22
N11	VSS_285	VSS_185	BC26
AD15	VSS_286	VSS_186	BC30
P22	VSS_287	VSS_187	BC40
P30	VSS_288	VSS_188	BC44
P32	VSS_289	VSS_189	BC52
P34	VSS_290	VSS_190	BH9
P42	VSS_291	VSS_191	BD48
P45	VSS_292	VSS_192	BD49
P47	VSS_293	VSS_193	BD5
R2	VSS_294	VSS_194	BE12
R52	VSS_295	VSS_195	BE16
L12	VSS_296	VSS_196	BE20
T41	VSS_297	VSS_197	BE24
T46	VSS_298	VSS_198	BE30
T49	VSS_299	VSS_199	BE34
T5	VSS_300	VSS_200	BE38
T8	VSS_301	VSS_201	BE42
U30	VSS_302	VSS_202	BE46
U31	VSS_303	VSS_203	BE48
U32	VSS_304	VSS_204	BE50
U34	VSS_305	VSS_205	BE6
P38	VSS_306	VSS_206	BE8
V11	VSS_307	VSS_207	BF3
P16	VSS_308	VSS_208	BF48
V19	VSS_309	VSS_209	BF51
V20	VSS_310	VSS_210	BG18
V21	VSS_311	VSS_211	BG24
V22	VSS_312	VSS_212	BG4
V30	VSS_313	VSS_213	BG44
V31	VSS_314	VSS_214	BH11
V32	VSS_315	VSS_215	BH15
V34	VSS_316	VSS_216	BH19
V35	VSS_317	VSS_217	BH23
V38	VSS_318	VSS_218	BH31
V43	VSS_319	VSS_219	BH35
V45	VSS_320	VSS_220	BH39
V46	VSS_321	VSS_221	BH43
V47	VSS_322	VSS_222	BH47
V49	VSS_323	VSS_223	BH7
V5	VSS_324	VSS_224	C12
V7	VSS_325	VSS_225	C50
V8	VSS_326	VSS_226	D51
V2	VSS_327	VSS_227	E12
V11	VSS_328	VSS_228	E16
V12	VSS_329	VSS_229	E20
V15	VSS_330	VSS_230	E24
V19	VSS_331	VSS_231	E30
V23	VSS_332	VSS_232	E34
V28	VSS_333	VSS_233	E38
V30	VSS_334	VSS_234	E42
V31	VSS_335	VSS_235	E46
V32	VSS_336	VSS_236	E48
V38	VSS_337	VSS_237	E6
V43	VSS_338	VSS_238	E8
V46	VSS_339	VSS_239	F49
V49	VSS_340	VSS_240	F5
V5	VSS_341	VSS_241	G10
V6	VSS_342	VSS_242	G14
V8	VSS_343	VSS_243	G18
P24	VSS_344	VSS_244	G2
T43	VSS_345	VSS_245	G22
AD51	VSS_346	VSS_246	G32
AT8	VSS_347	VSS_247	G36
AD47	VSS_348	VSS_248	G40
V47	VSS_349	VSS_249	G44
AT12	VSS_350	VSS_250	G52
AM6	VSS_351	VSS_251	AF39
AT13	VSS_352	VSS_252	H16
AM5	VSS_353	VSS_253	H20
AK45	VSS_354	VSS_254	H30
AK39	VSS_355	VSS_255	H34
AV14	VSS_356	VSS_256	H38
	VSS_366	VSS_257	H42
		VSS_258	



DRAW	MS YANG	DATE	8/11/2009	TITLE	BREMEN-M PCH IBEX PEAK(5/5)	SAMSUNG ELECTRONICS
CHECK	SE LEE	DEV. STEP	PV			PART NO. BA41-01174A
APPROVAL	MK KIM	REV	REV 0.9			
MODULE CODE	undefined	LAST EDIT				
				October 20, 2009 21:30:55 PM	PAGE	19 OF 56



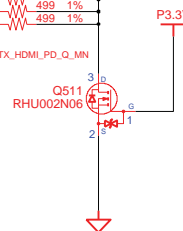
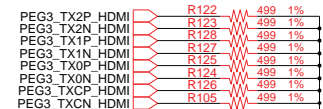
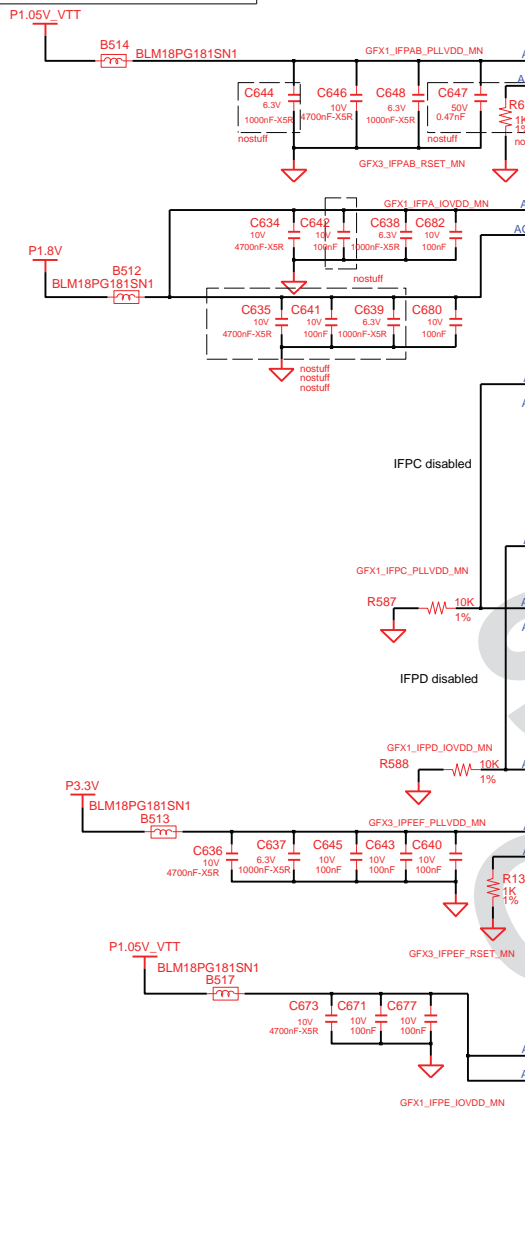


EGFX_CORE

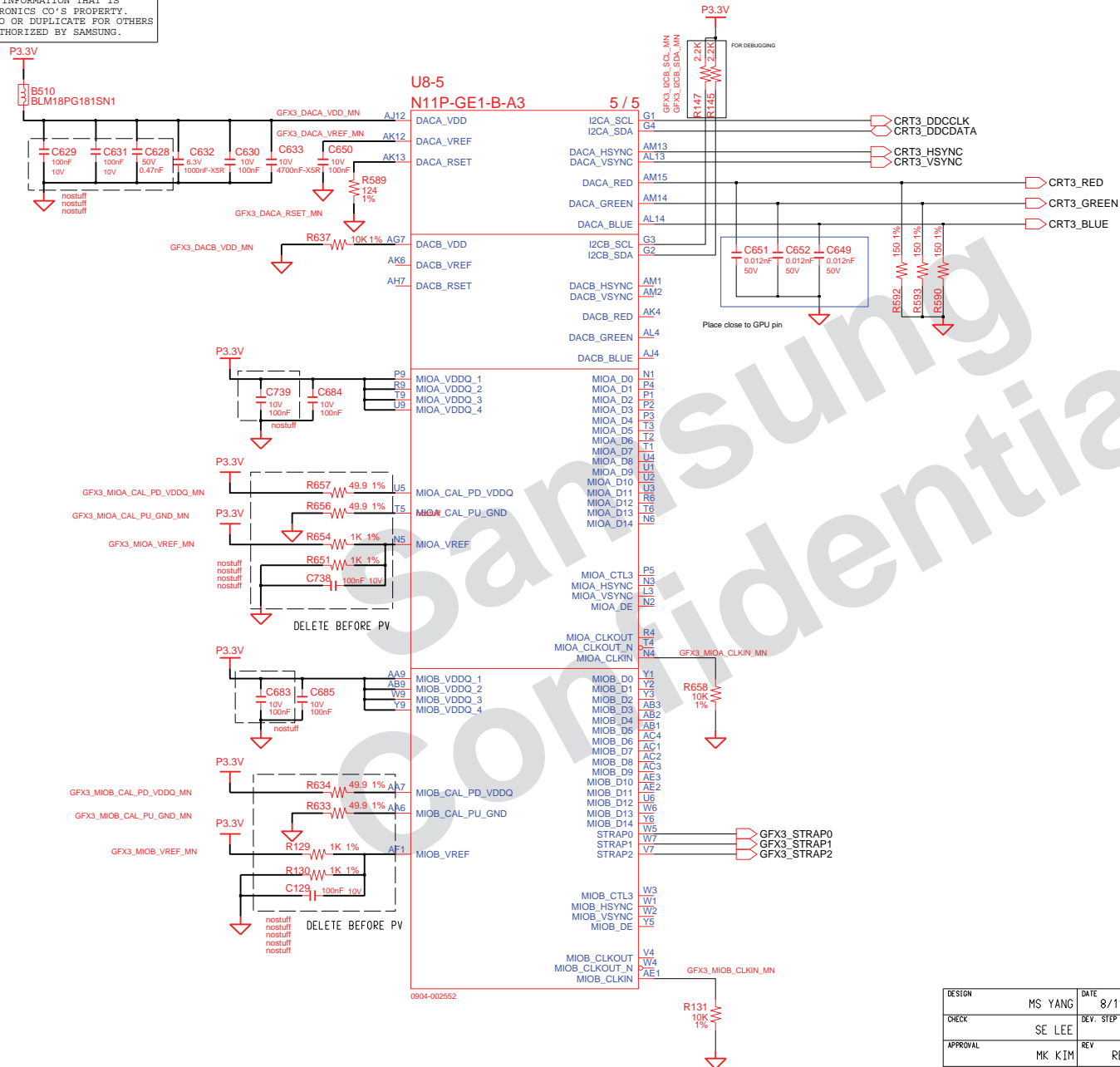
D:/Users/mobile39/mentor/Bremen/PV/Bremen-M-MAIN

U8-4
N11P-GE1-B-A3

4 / 5



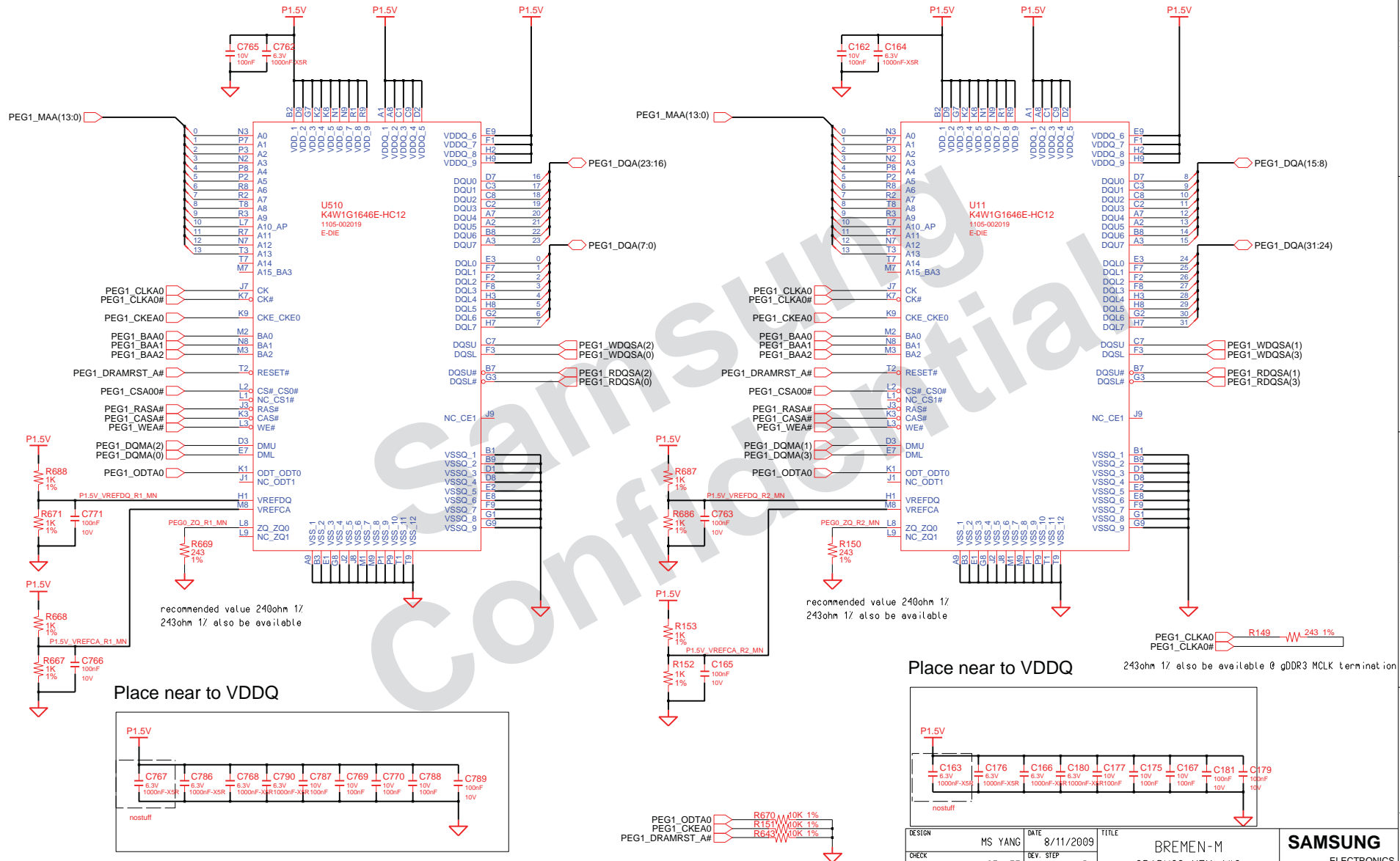
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CHECK	SE LEE	DEV. STEP	PV			
APPROVAL	MK KIM	REV	REV 0.9			
MODULE CODE		LAST EDIT		October 20, 2009 21:30:55 PM	PAGE 23 OF 56	



0904-002552

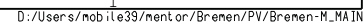
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CHECK	SE LEE	DEV. STEP	PV			PART NO. BA41-01174A
APPROVAL	MK KIM	REV	REV 0.9			
MODULE CODE		LAST EDIT	October 20, 2009 21:30:55 PM	PAGE	24	OF 56

A-Channel #0



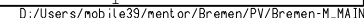
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APPROVAL	MK KIM	REV	REV 0.9		GRAPHIC.MEM A#0	
MODULE CODE		LAST EDIT				
October 20, 2009 21:30:55 PM						PAGE 25 OF 56

1



DESIGN	MS YANG	DATE	8/11/2009	TITLE	BREMEN-M GRAPHIC_MEM A#1 GRAPHIC_MEM A#1	SAMSUNG ELECTRONICS
CHECK	SE LEE	DEV. STEP	PV			
APPROVAL	MK KIM	REV	REV 0.9			
						PART NO. BA41-01174A
MODULE CODE		LAST EDIT		October 20, 2009 21:30:55 PM		PAGE 26 OF 56

1

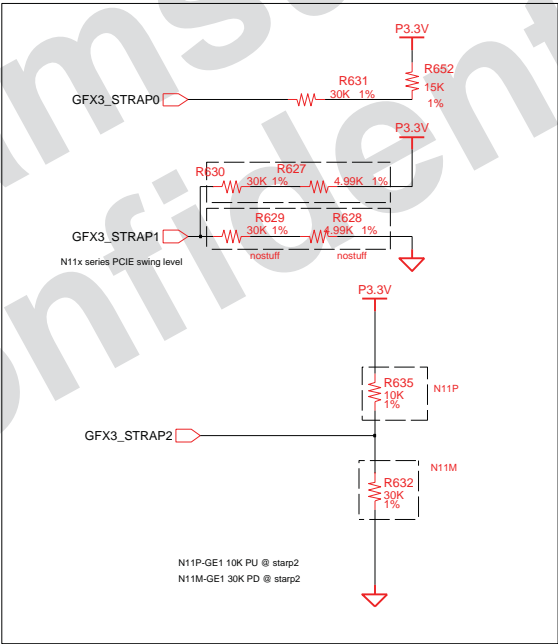
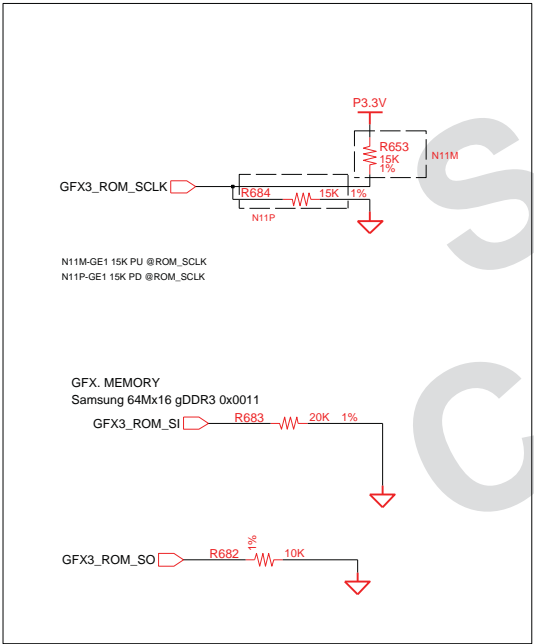


DESIGN	MS YANG	DATE	8/11/2009	TITLE BREMEN-M GRAPHIC_MEM C#1 GRAPHIC_MEM C#1	SAMSUNG ELECTRONICS	
CHECK	SE LEE	DEV. STEP	PV			
APPROVAL	MK KIM	REV	REV 0.9			PART NO. BA41-01174A
MODULE CODE		LAST EDIT	October 20, 2009 21:30:55 PM			PAGE 28 OF 56

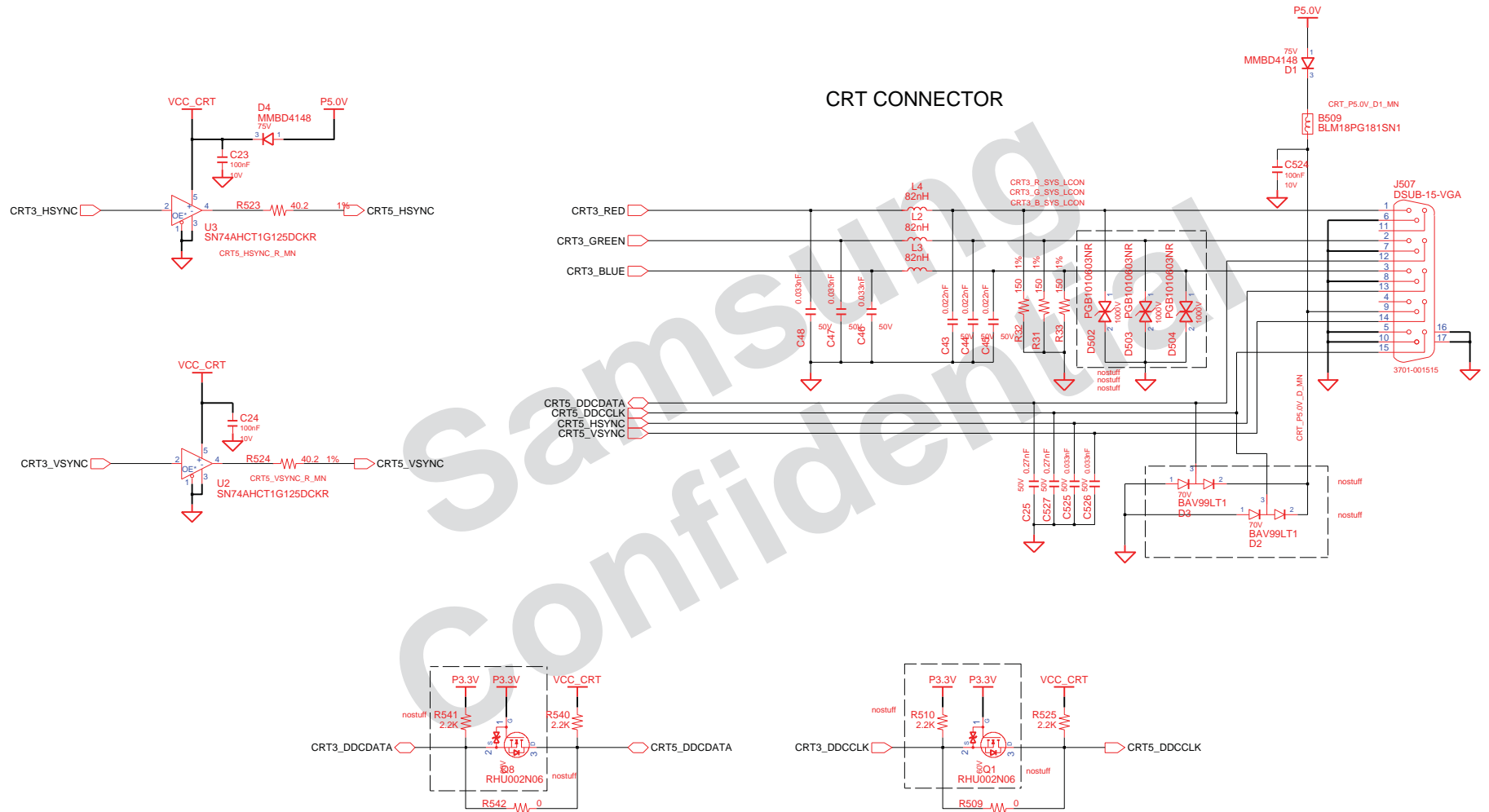
N11x_40nm STRAP

STRAP PIN	BIT 3	BIT 2	BIT 1	BIT0
ROM_SO	XCLK_417	FB_0_BAR_SIZE	SMB_ALT_ADDR	VGA_DEVICE
ROM_SCLK	PCI_DEVID[4]	SUB_VENDOR	SLOT_CLK_CFG	PEX_PLL_EN_TERM
ROM_SI	RAMCFG[3]	RAMCFG[2]	RAMCFG[1]	RAMCFG[0]
STRAP2	PCI_DEVID[3]	PCI_DEVID[2]	PCI_DEVID[1]	PCI_DEVID[0]
STRAP1	3GIO_PADCFG[3]	3GIO_PADCFG[2]	3GIO_PADCFG[1]	3GIO_PADCFG[0]
STRAP0	USER[3]	USER[2]	USER[1]	USER[0]

RESISTOR	PULL UP	PULL DOWN
5K	1000	0000
10K	1001	0001
15K	1010	0010
20K	1011	0011
25K	1100	0100
30K	1101	0101
35K	1110	0110
45K	1111	0111



CRT



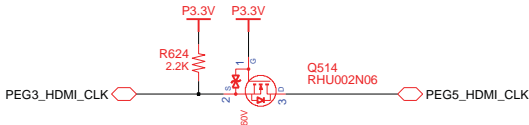
DESIGN	MS YANG	DATE	8/11/2009	TITLE	BREMEN-M GRAPHICS_IF CRT	SAMSUNG ELECTRONICS
CHECK	SE LEE	DEV. STEP	PV			PART NO. BA41-01174A
APPROVAL	MK KIM	REV	REV 0.9			
MODULE CODE		LAST EDIT				

October 20, 2009 21:30:55 PM

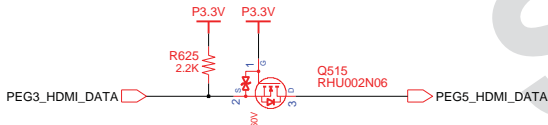
PAGE 31 OF 56

HDMI

FOR HDMI VERIFICATION TEST

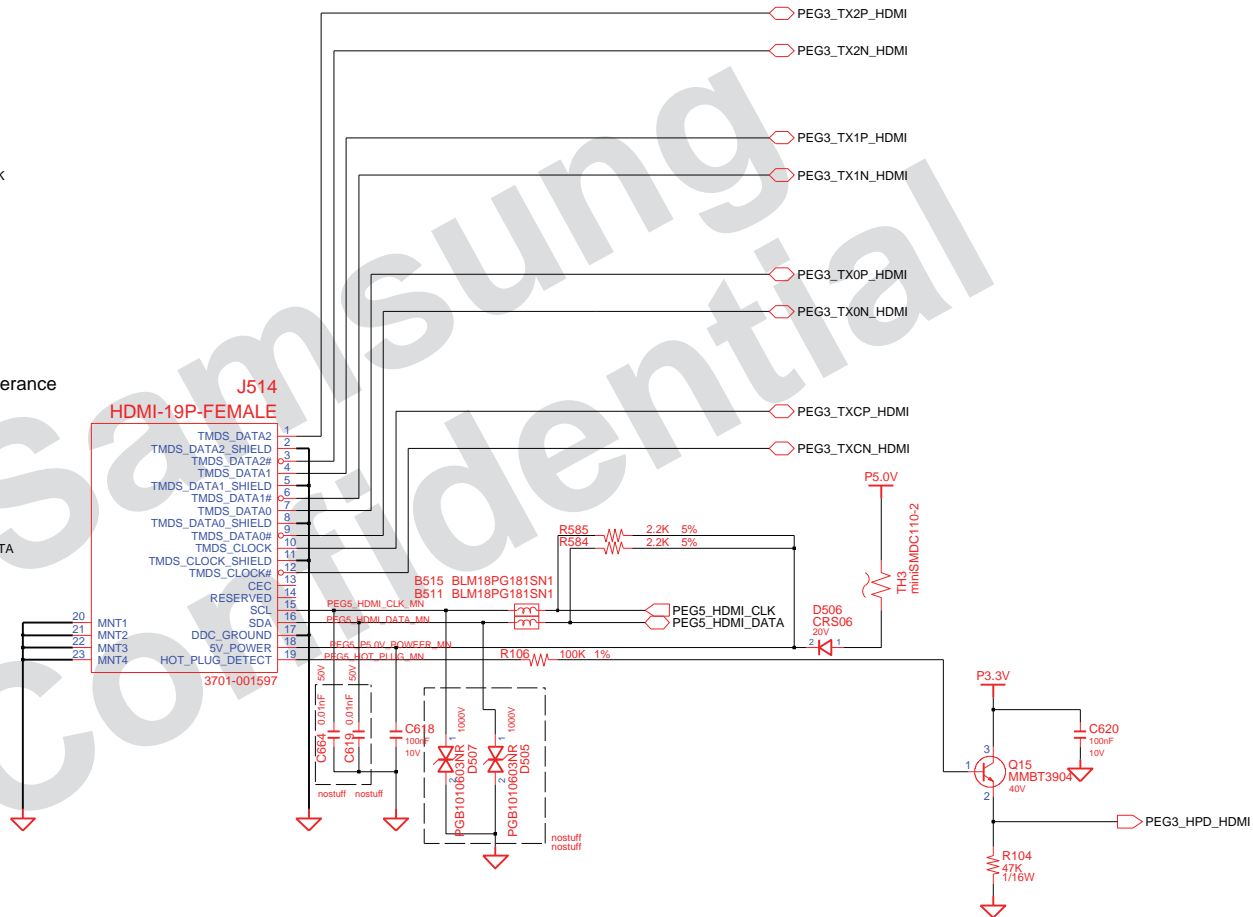


N10x/N11x_40nm HDMI/DP/LVDS support only 3.3V voltage tolerance



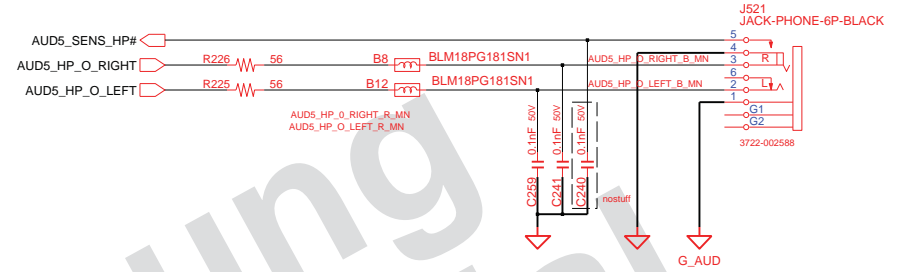
J514 HDMI-19P-FEMALE

- 1 TMDS_DATA2
- 2 TMDS_DATA2_SHIELD
- 3 TMDS_DATA2#
- 4 TMDS_DATA1
- 5 TMDS_DATA1#
- 6 TMDS_DATA0
- 7 TMDS_DATA0_SHIELD
- 8 TMDS_DATA0#
- 9 TMDS_CLOCK
- 10 TMDS_CLOCK_SHIELD
- 11 TMDS_CLOCK#
- 12 RESERVED
- 13 CEC
- 14 SCL
- 15 SDA
- 16 MNT1
- 17 MNT2
- 18 MNT3
- 19 MNT4
- 20 DDC_GROUND
- 21 5V_POWER
- 22 HOT_PLUG_DETECT
- 23

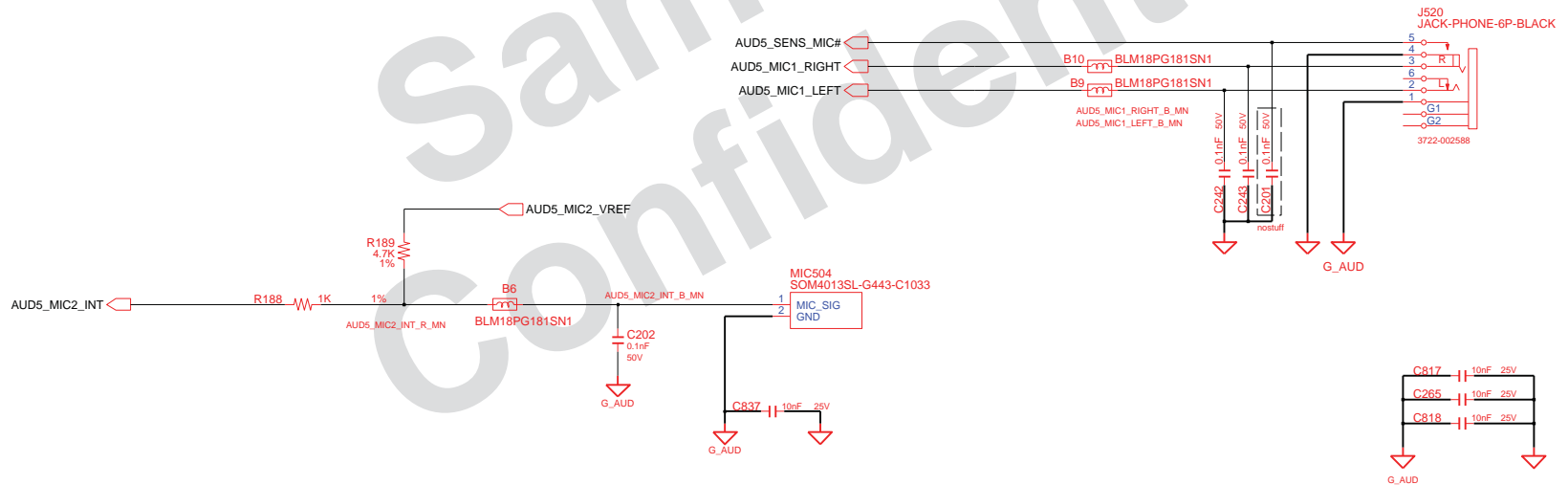


DESIGN	MS YANG	DATE	8/11/2009	TITLE	BREMEN-M	SAMSUNG
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APPROVAL	MK KIM	REV	REV 0.9	HDMI		
MODULE CODE		LAST EDIT				
				October 20, 2009 21:30:55 PM	PAGE 32	OF 56

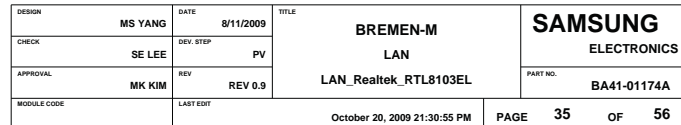
HEADPHONE(BLACK)



MIC JACK(BLACK)

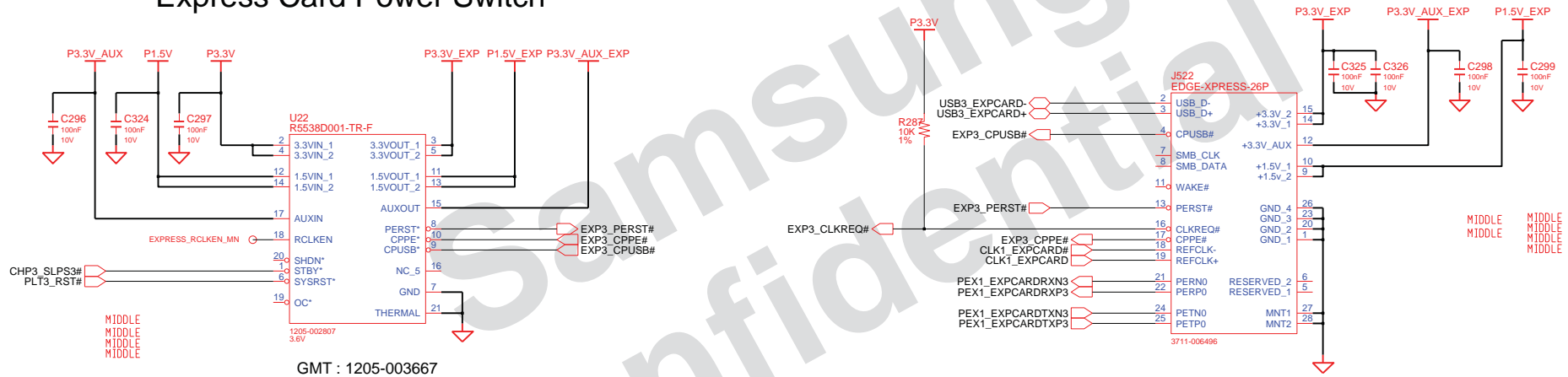


DESIGN	MS YANG	DATE	8/11/2009	TITLE	BREMEN-M HDA_CODEC	SAMSUNG ELECTRONICS
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APPROVAL	MK KIM	REV	REV 0.9	MODULE CODE	LAST EDIT	PART NO. BA41-01174A
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Express Card

Express Card Power Switch



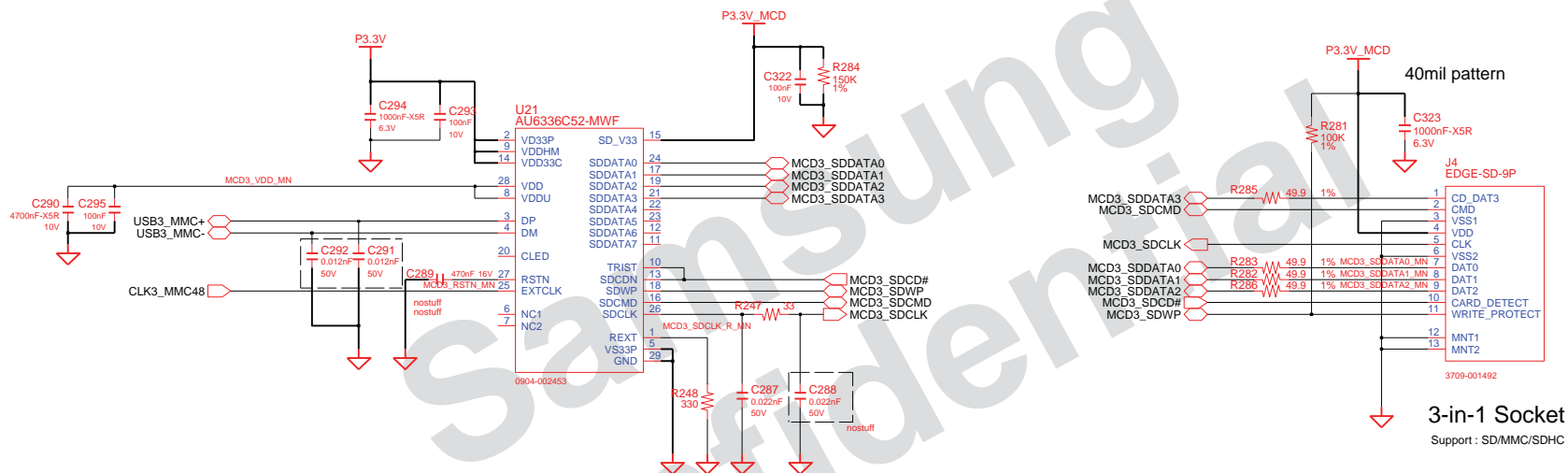
GMT : 1205-003667

TYPE - I

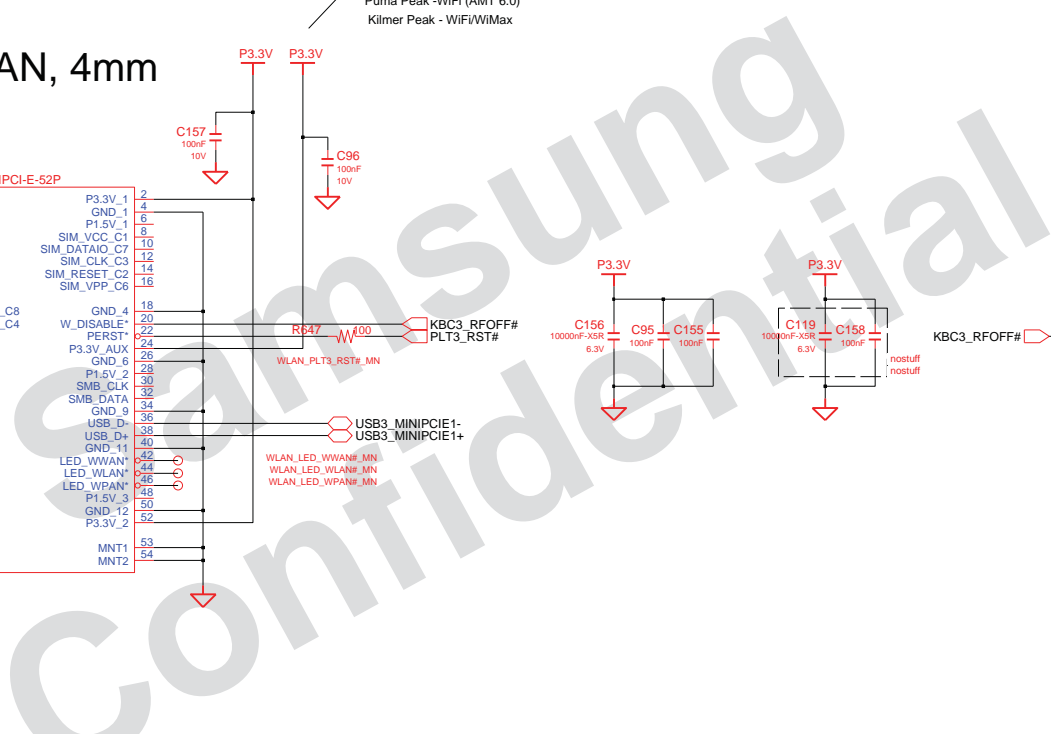


DESIGN	MS YANG	DATE	8/11/2009	TITLE	BREMEN-M EXPRESS CARD	SAMSUNG ELECTRONICS
CHECK	SE LEE	DEV. STEP	PV			
APPROVAL	MK KIM	REV	REV 0.9			
MODULE CODE		LAST EDIT				
				October 20, 2009 21:30:55 PM	PAGE 36	OF 56

3 IN 1 CARD (AU6336)



DESIGN	MS YANG	DATE	8/11/2009	BREMEN-M MULTICAM 3 IN 1 CARD(GL827S)	SAMSUNG ELECTRONICS			
CHECK	SE LEE	DEV. STEP	PV		PART NO.	BA41-01174A		
APPROVAL	MK KIM	REV	REV 0.9					
MODULE CODE	LAST EDIT				October 20, 2009 21:30:55 PM	PAGE	37	OF

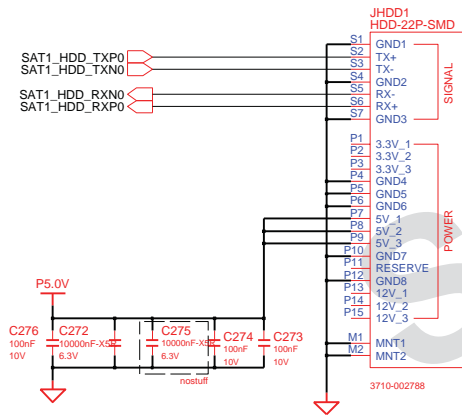


COM-22C-015(1996.6.5) REV. 3

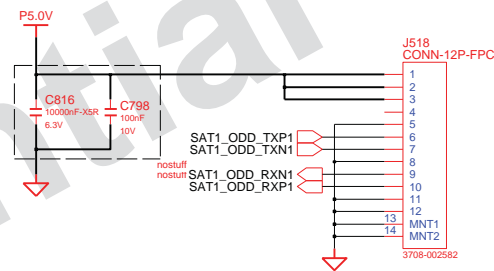
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SATA I/F CONN

SATA HDD CONN

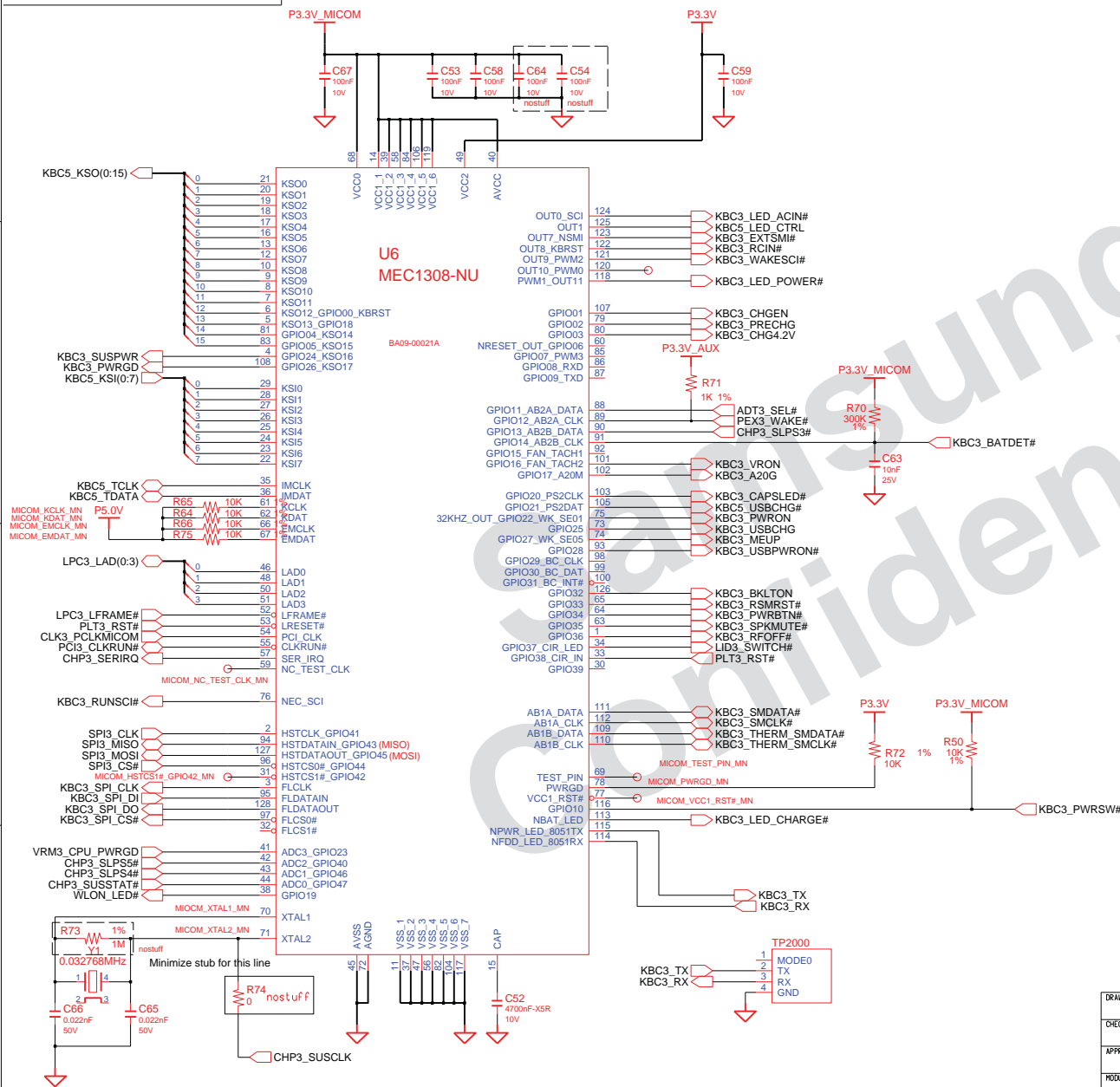


MAIN TO SUB SATA ODD CONN



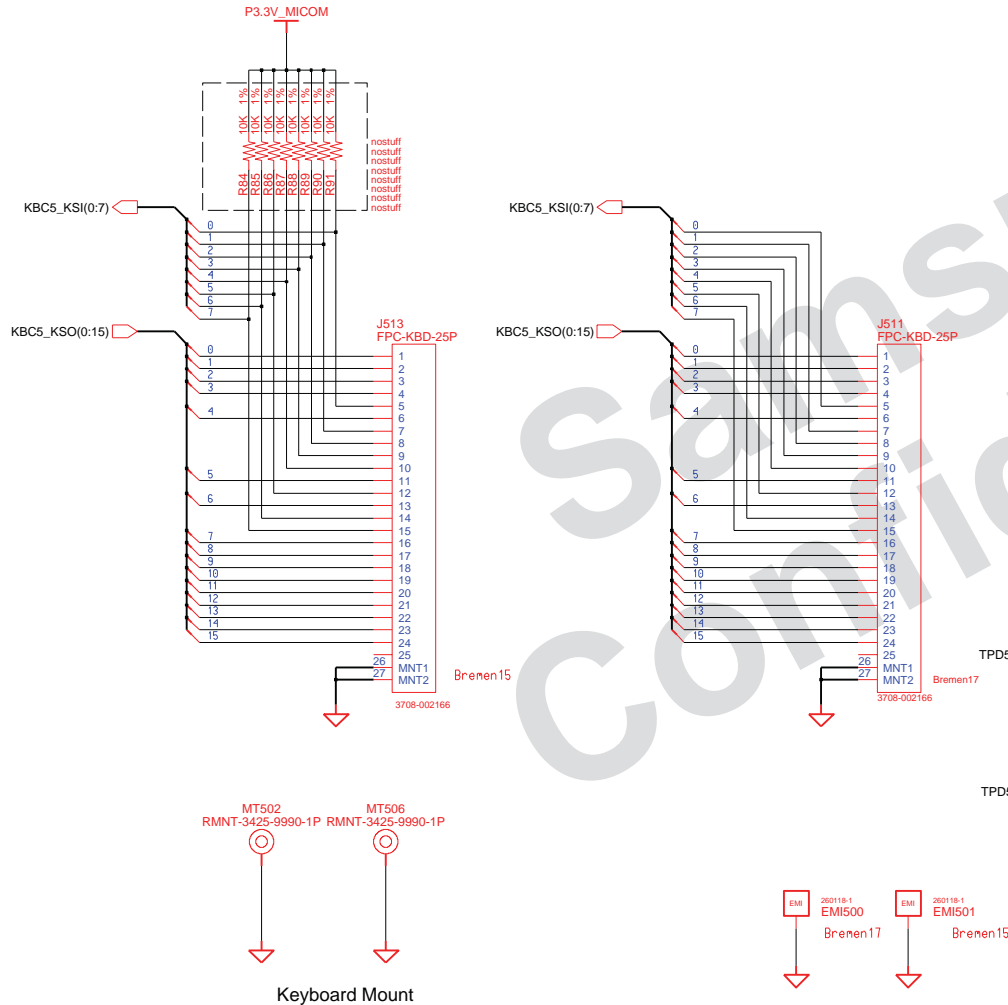
DESIGN	MS YANG	DATE	8/11/2009	TITLE	BREMEN-M SATA_DEVICES	SAMSUNG ELECTRONICS
CHECK	SE LEE	DEV. STEP	PV			
APPROVAL	MK KIM	REV	REV 0.9	HDD & ODD SUB CONNECTOR	PART NO.	BA41-01174A
MODULE CODE		LAST EDIT		October 20, 2009 21:30:55 PM	PAGE	39 OF 56

MAIN BOARD (MICOM)

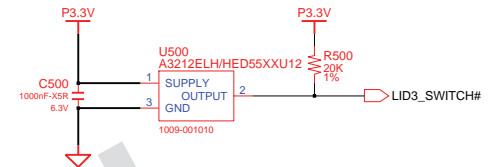


Micom Glue Logic

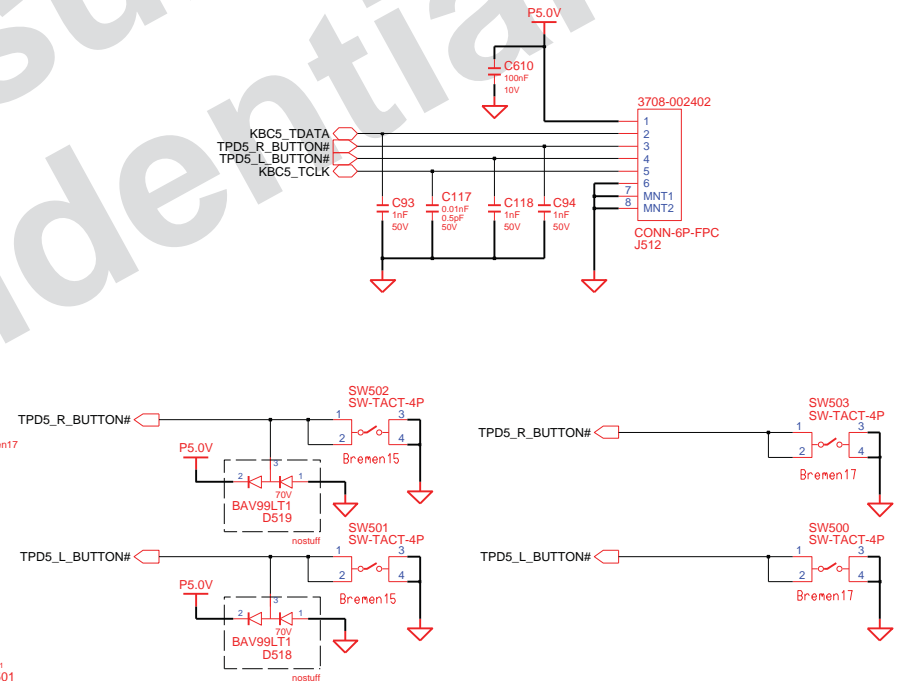
KEYBOARD



LID_SWITCH

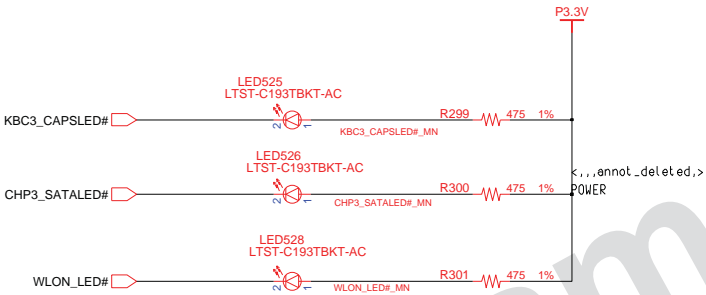


TOUCHPAD

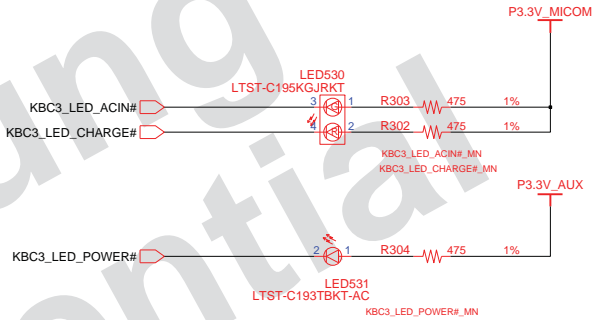


DESIGN	MS YANG	DATE	8/11/2009	TITLE	BREMEN-M MICOM GLUE LOGIC KEYBOARD & TOUCHPAD	SAMSUNG ELECTRONICS
CHECK	SE LEE	DEV. STEP	PV			PART NO. BA41-01174A
APPROVAL	MK KIM	REV	REV 0.9			
MODULE CODE		LAST EDIT				
October 20, 2009 21:30:55 PM				PAGE	41	OF 56

FUNCTION KEY LED



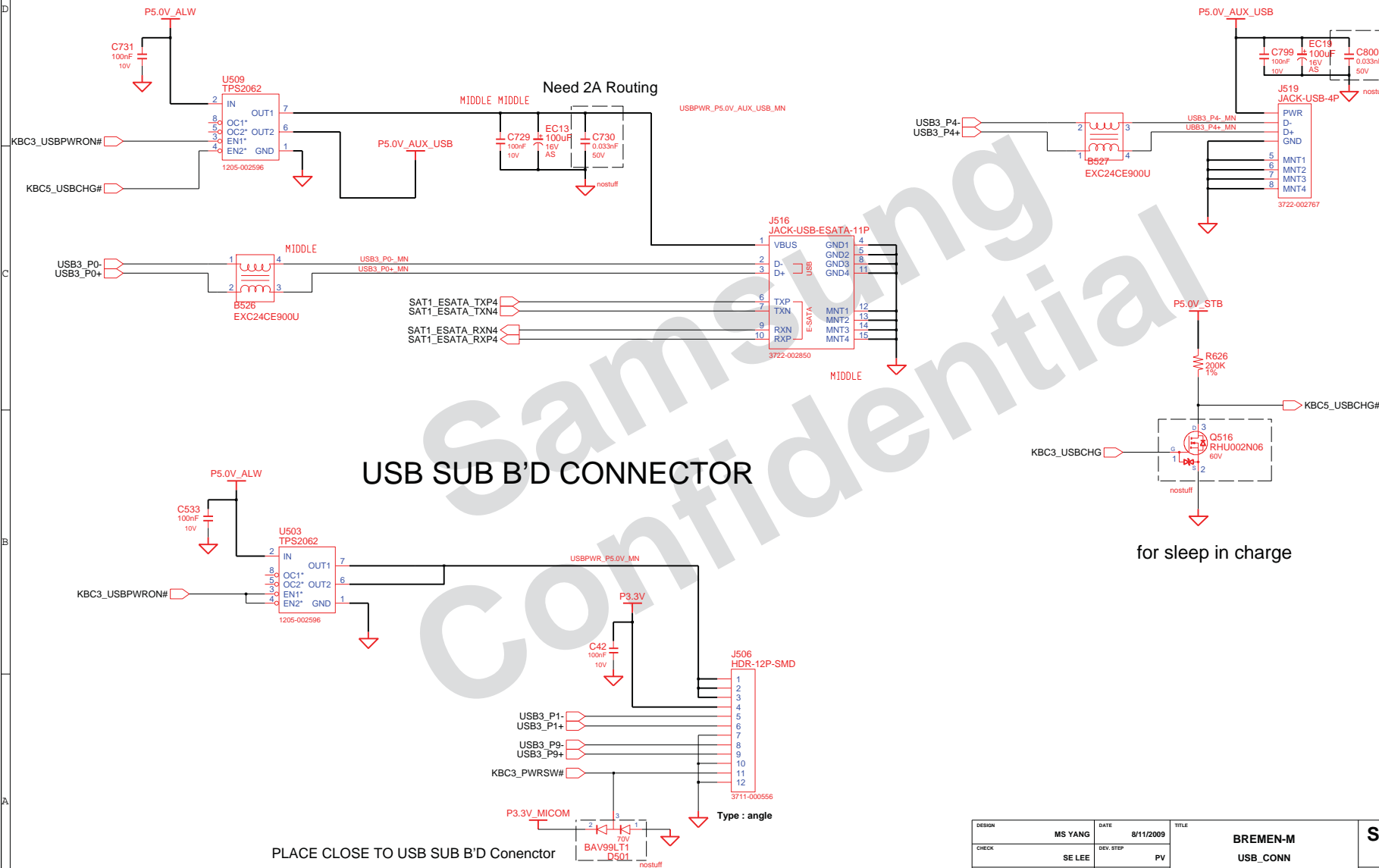
ADAPTERIN/CHARGING LED



DRAW	MS YANG	DATE	8/11/2009	TITLE	BREMEN-M LED_SWITCH	SAMSUNG ELECTRONICS
CHECK	SE LEE	DEV. STEP	PV			
APPROVAL	MK KIM	REV	REV 0.9			
MODULE CODE		LAST EDIT				
				October 20, 2009 21:30:55 PM	PAGE 42	OF 56

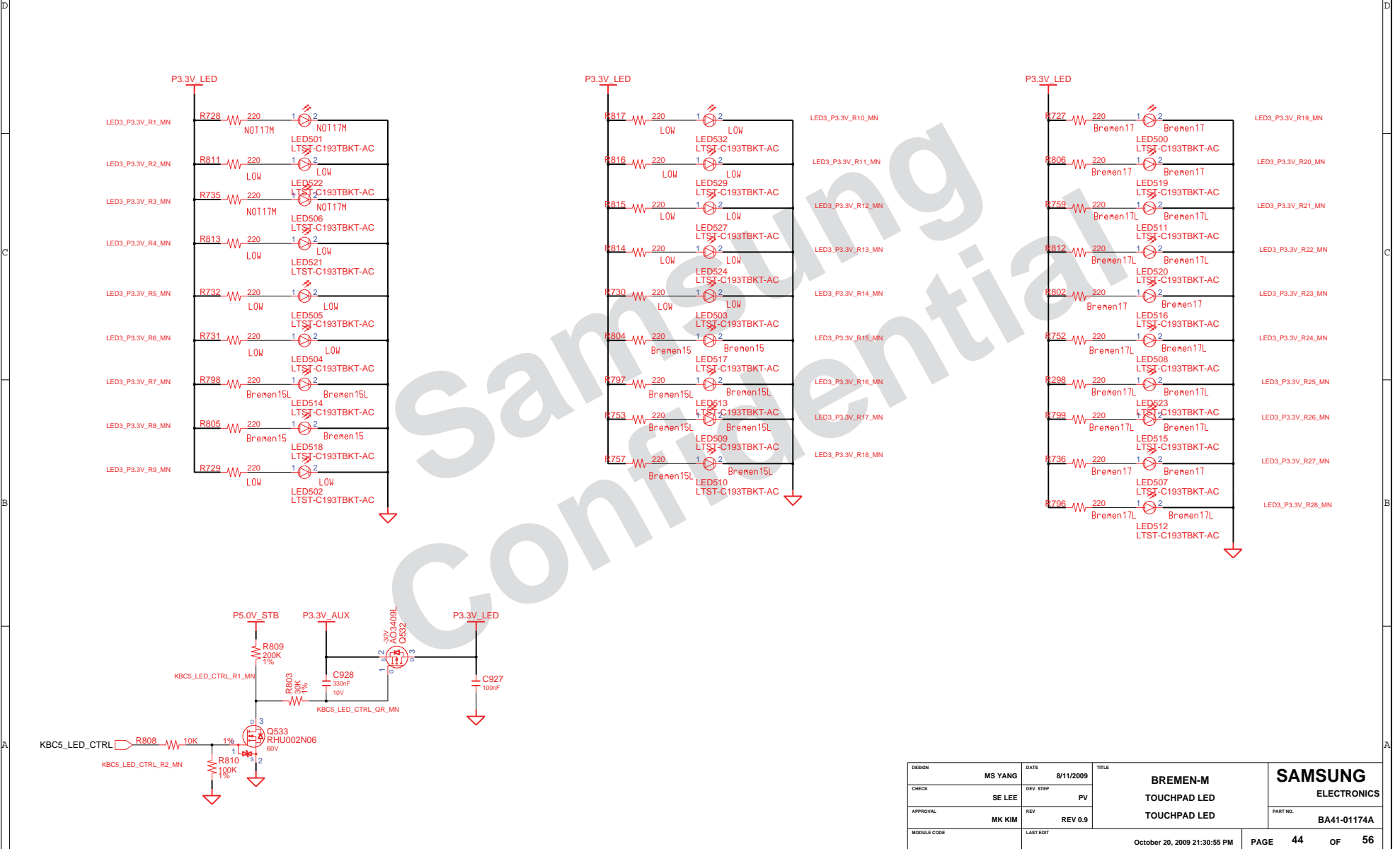
USB + eSATA CONNECTOR

USB Single connector



DESIGN	MS YANG	DATE	8/11/2009	TITLE	BREMEN-M USB_CONN	SAMSUNG ELECTRONICS
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APPROVAL	MK KIM	REV	REV 0.9			
MODULE CODE		LAST EDIT				
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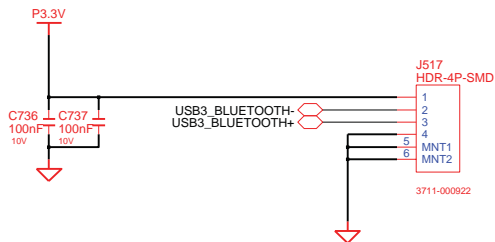
Touchpad LED



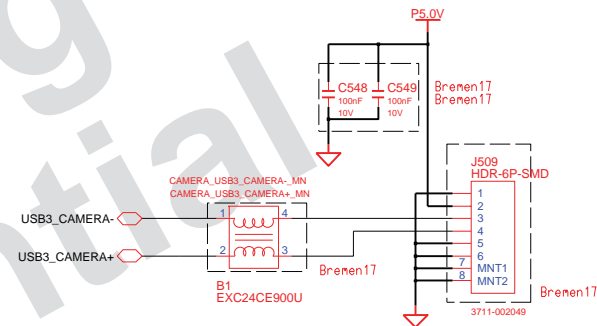
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CHECK	SE LEE	DEV. STEP	PV					
APPROVAL	MK KIM	REV	REV 0.9		TOUCHPAD LED		PART NO. BA41-01174A	
MODULE CODE	LAST EDIT			October 20, 2009 21:30:55 PM		PAGE	44	OF 56

USB I/F Devices

Bluetooth Interface

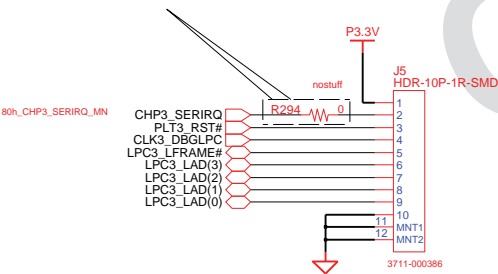


CAMERA (17Inch)

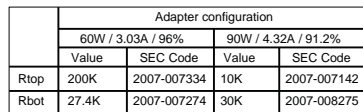


80h PORT DEBUG

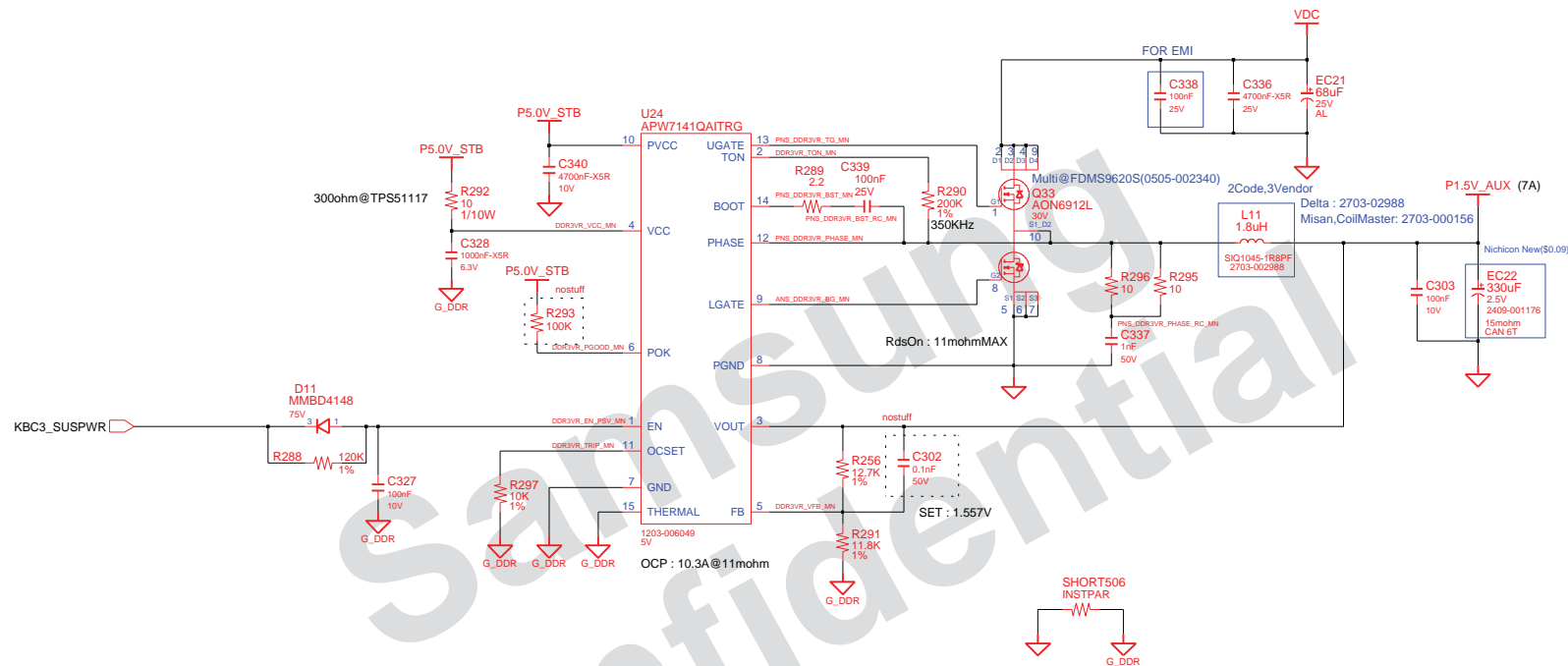
For MICOM 80H Debug Port Test



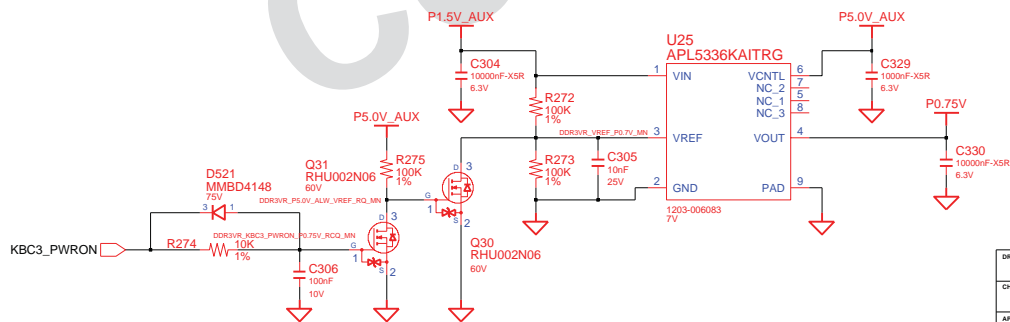
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CHECK	SE LEE	DEV. STEP	PV			
APPROVAL	MK KIM	REV	REV 0.9		BLUETOOTH & CAMERA	PART NO. BA41-01174A
MODULE CODE		LAST EDIT				
				October 20, 2009 21:30:55 PM	PAGE	45 OF 56


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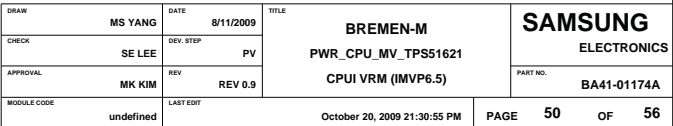
DDR3 Power



DDR3 VTT(0.75V)

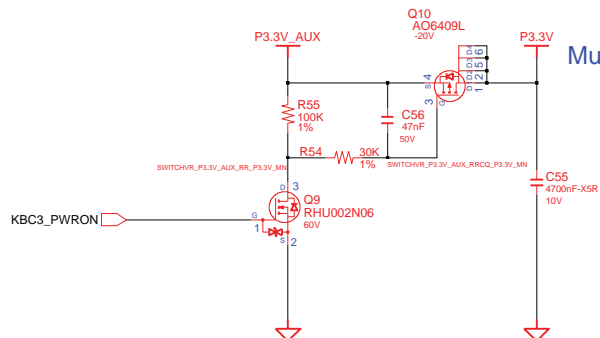


DRAW	MS YANG	DATE	8/11/2009	BREMEN-M PWR_MEMORY DDR3 POWER	
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APPROVAL	MK KIM	REV	REV 0.9		
MODULE CODE		LAST EDIT		October 20, 2009 21:30:55 PM	PART NO. BA41-01174A
undefined		PAGE 49 OF 56			



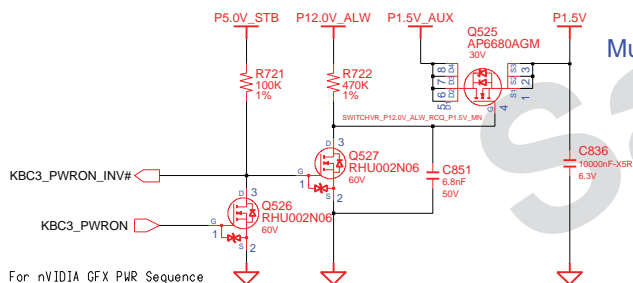
Switched Power

Switched Power On (P3.3V)



Multi@AP2607GY,Si3433BDV

Switched Power On (P1.5V)



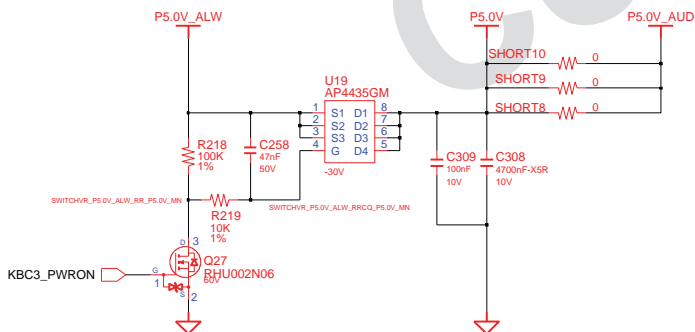
Multi@AP6680BGM,AO4476L

For nVIDIA GFX PWR Sequence

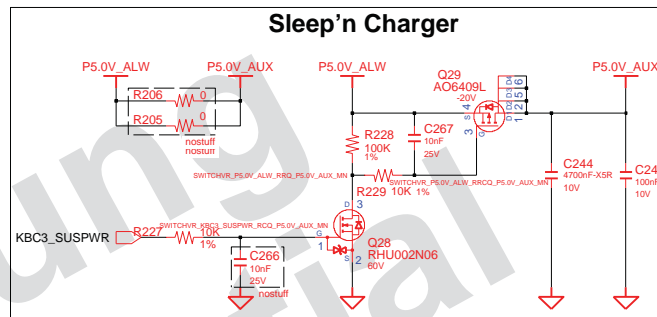
NVDD(EGFX_CORE) First and then FBVDDQ(gDDR3)

Switched Power On (P5.0V)

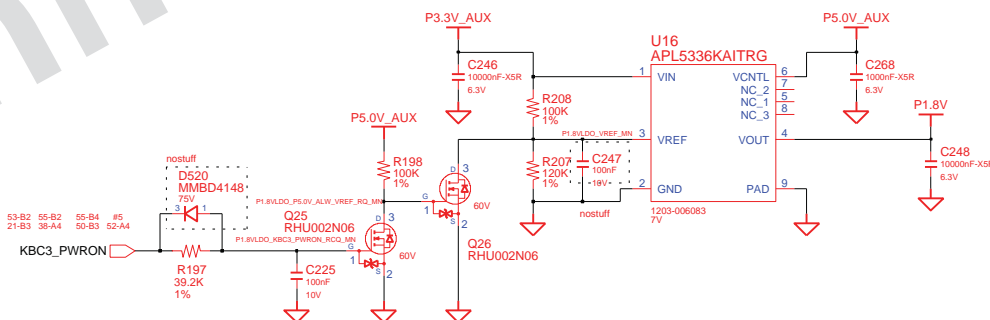
Multi@Si443DDY



Sleep'n Charger

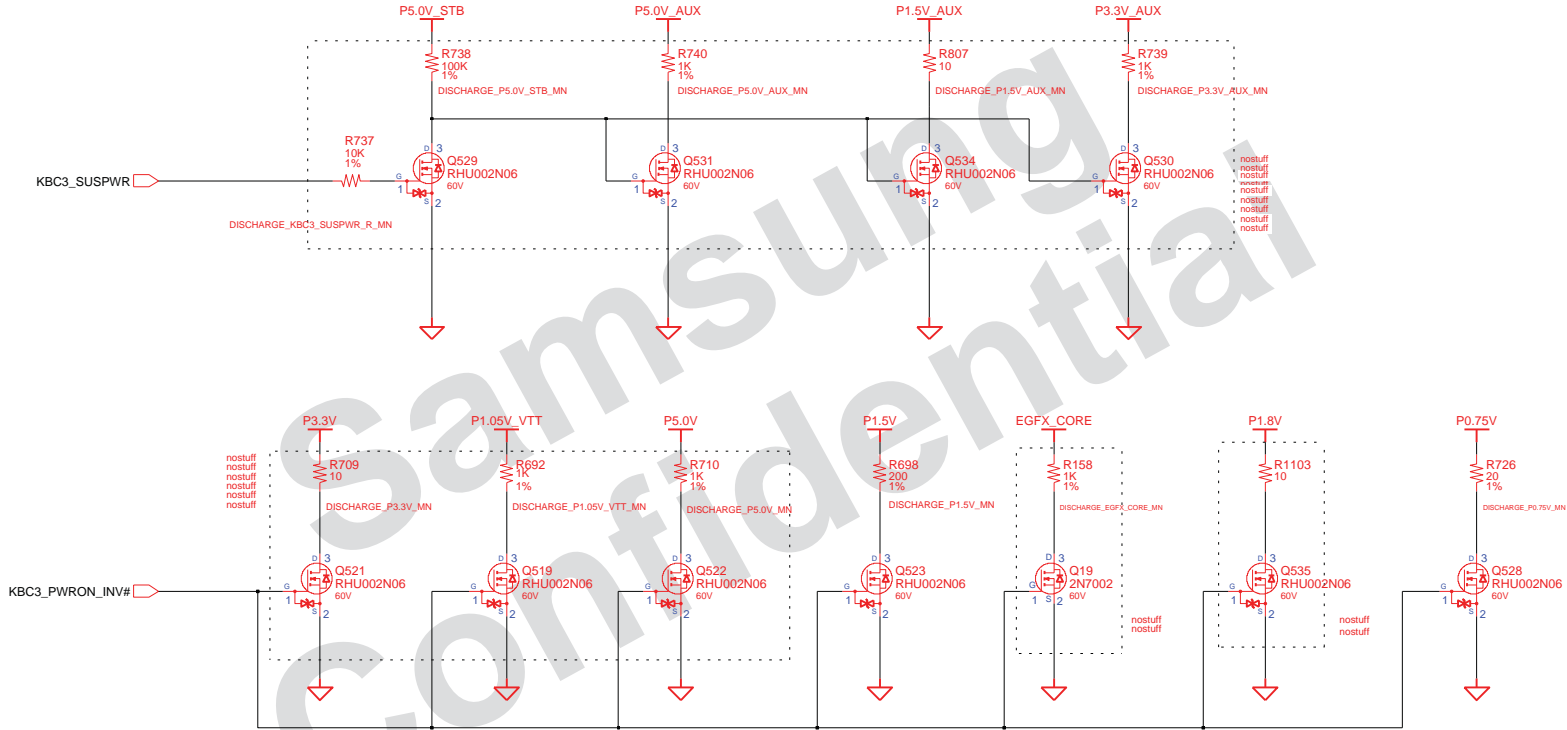


P1.8V(LDO)



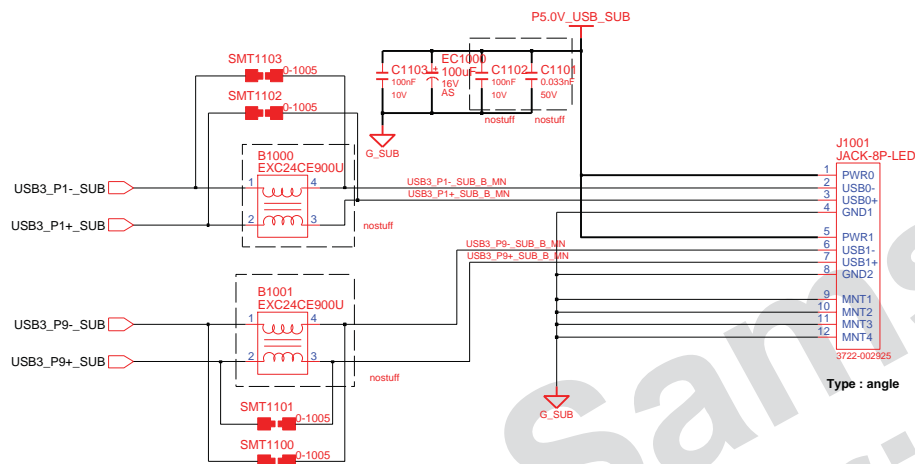
DRAW	MS YANG	DATE	8/11/2009	TITLE	BREMEN-M PWR_MV_SWITCHED SWITCHED POWER	SAMSUNG ELECTRONICS
CHECK	SE LEE	DEV. STEP	PV			PART NO. BA41-01174A
APPROVAL	MK KIM	REV	REV 0.9			
MODULE CODE		LAST EDIT				
October 20, 2009 21:30:55 PM						PAGE 52 OF 56

POWER DISCHARGER

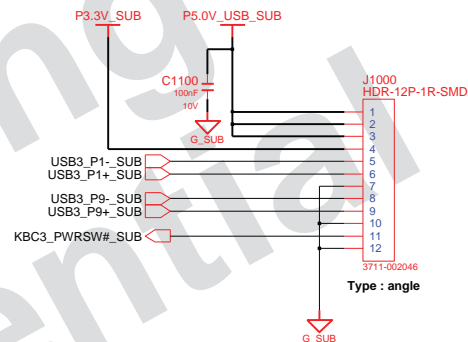


DRAW	MS YANG	DATE	8/11/2009	TITLE	BREMEN-M	SAMSUNG
CHECK	SE LEE	DEV. STEP	PV	PWR_MV_DISCHARGER	DISCHARGING LOGIC	ELECTRONICS
APPROVAL	MK KIM	REV	REV 0.9			PART NO.
MODULE CODE	undefined	LAST EDIT				BA41-01174A
				October 20, 2009 21:30:55 PM	PAGE	53 OF 56

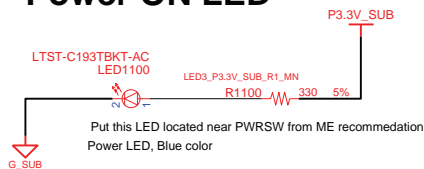
2 USB PORT & POWER S/W SUB B'D



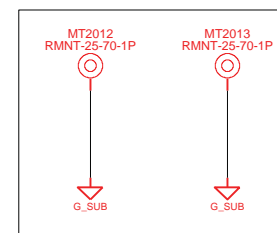
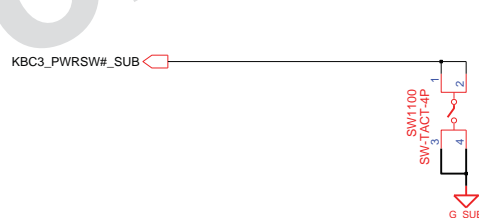
SUB TO MAIN USB CONN



Power ON LED



Power Button



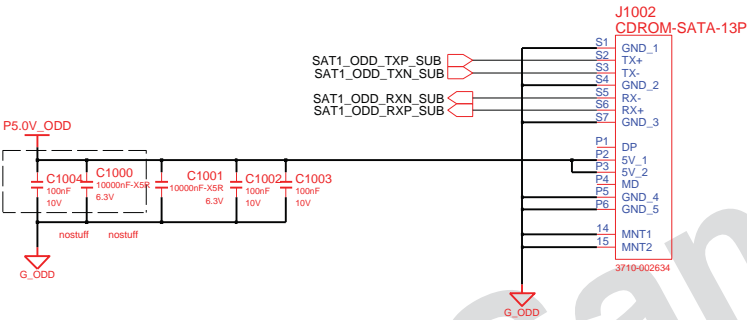
USB sub board mount hole

DESIGN	MS YANG	DATE	8/11/2009	TITLE	BREMEN-M SUB BOARD1	SAMSUNG ELECTRONICS
CHECK	SE LEE	DEV. STEP	PV			
APPROVAL	MK KIM	REV	REV 0.9			
MODULE CODE		LAST EDIT				
				October 20, 2009 21:30:55 PM	PAGE 54	OF 56

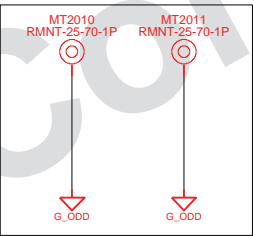
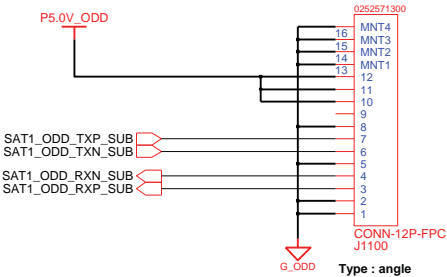
SATA ODD SUB BOARD

SATA ODD SUB BOARD

SATA ODD CONN

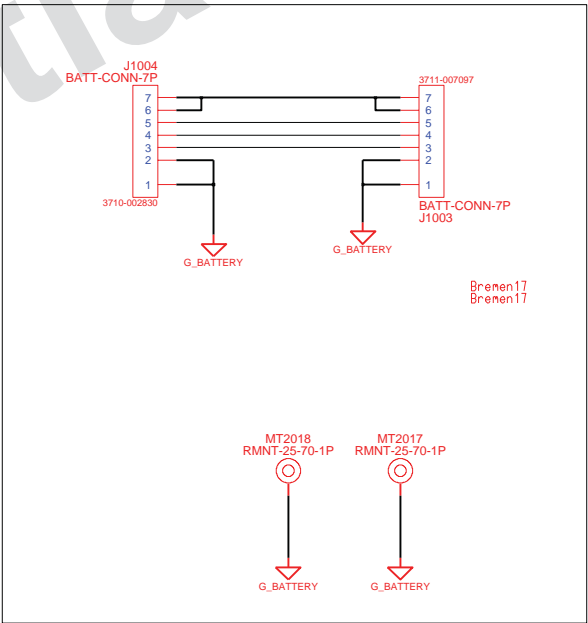


SUB TO MAIN SATA ODD CONN



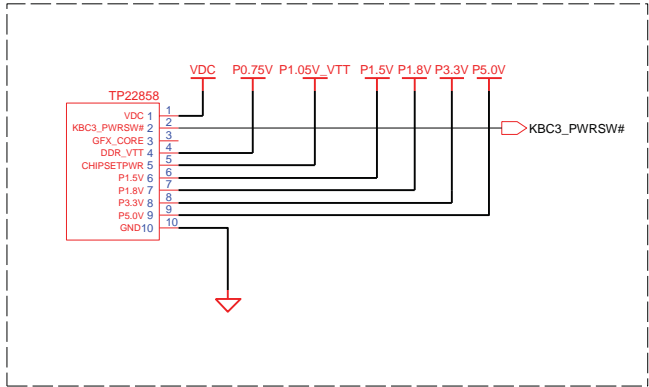
ODD sub board mount hole

17" BATTERY SUBBOARD

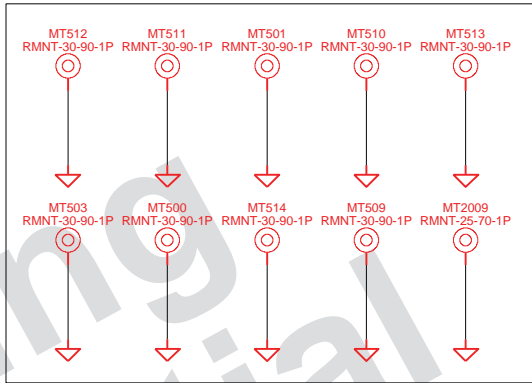


DRAW	MS YANG	DATE	8/11/2009	TITLE	BREMEN-M SUB BOARD2	SAMSUNG ELECTRONICS
CHECK	SE LEE	DEV. STEP	PV			
APPROVAL	MK KIM	REV	REV 0.9			
MODULE CODE	undefined	LAST EDIT				
				October 20, 2009 21:30:55 PM	PAGE 55	OF 56

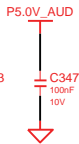
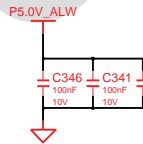
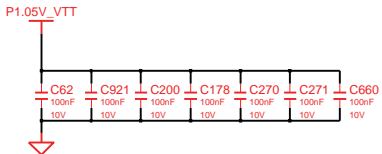
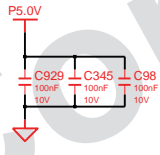
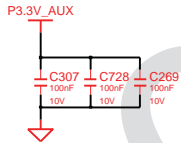
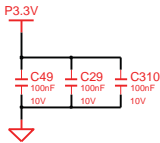
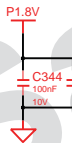
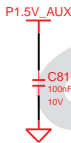
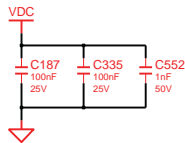
ICT PORT



Mainboard Mount ((30,80)x9), ((30,90)x9), ((25,70)x1))



Top : (30,80) x 9
Bot : (30,90) x 9



DRAW	MS YANG	DATE	8/11/2009	TITLE	BREMEN-M	SAMSUNG
CHECK	SE LEE	DEV. STEP	PV	ICT PORT	ICT PORT	ELECTRONICS
APPROVAL	MK KIM	REV	REV 0.9	ICT PORT	ICT PORT	PART NO.
MODULE CODE		LAST EDIT				BA41-01174A
				October 20, 2009 21:30:55 PM	PAGE	56 OF 56

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